

NCN@Purdue - Intel Summer School: July 14-25, 2008

## **Physics of *Nanoscale Transistors*: Lecture 1:**

# **A Review of MOSFET Fundamentals**

***Mark Lundstrom***

Network for Computational Nanotechnology  
Purdue University  
West Lafayette, Indiana USA

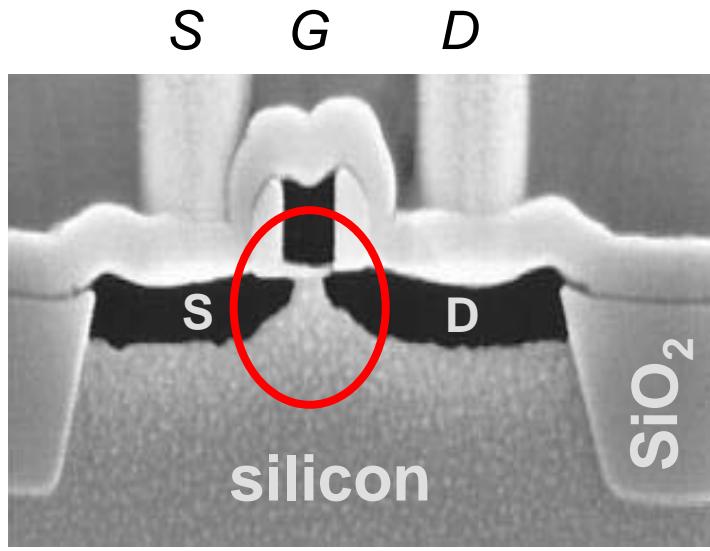
# outline

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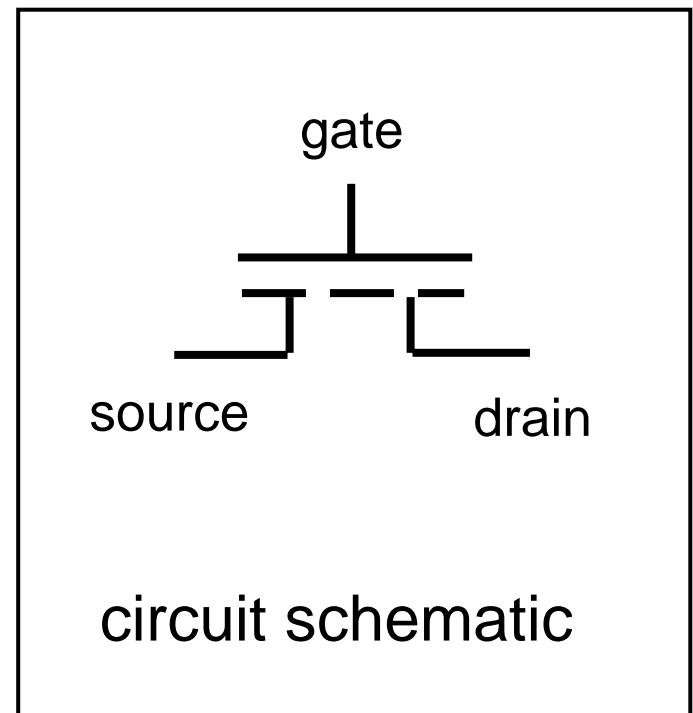
- 1) Introduction
- 2) MOSFET theory
- 3) Device performance metrics
- 4) The barrier model of a MOSFET
- 5) Carrier transport in MOSFETs
- 6) Summary

# transistors

## physical structure



(Texas Instruments, 1997)



“The transistor was probably the most important invention of the 20th century,” Ira Flatow, Transistorized! [www.pbs.org/transistor](http://www.pbs.org/transistor)

# MOSFETs

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For representative dimensions and parameters of current and future MOSFETs, see:

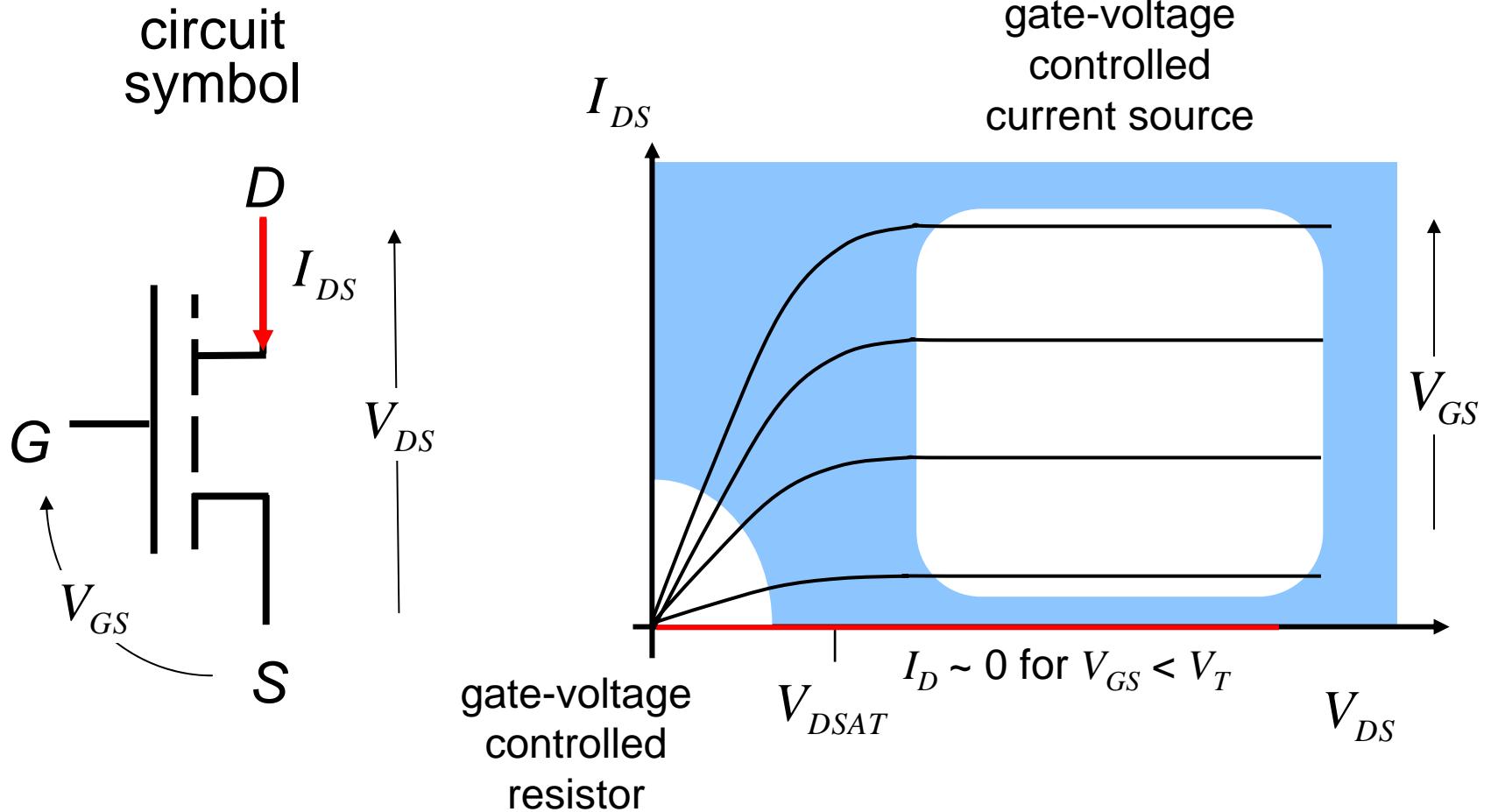
International Technology Roadmap for Semiconductors  
(ITRS)

especially the chapter:

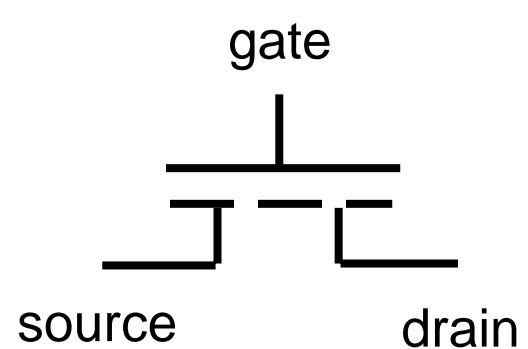
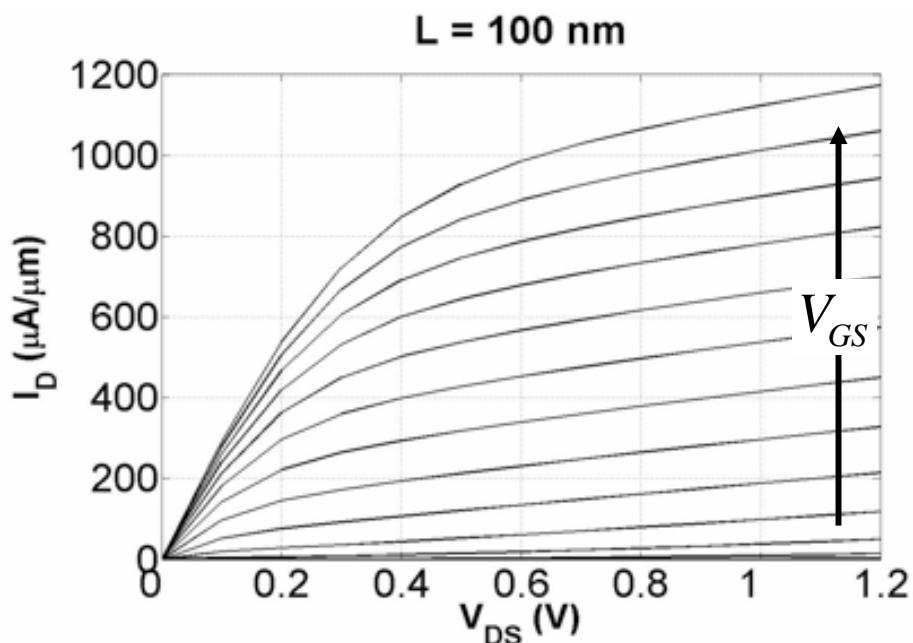
PIDS: Process Integration and Device Sciences.

<http://public.itrs.net>

# IV characteristics



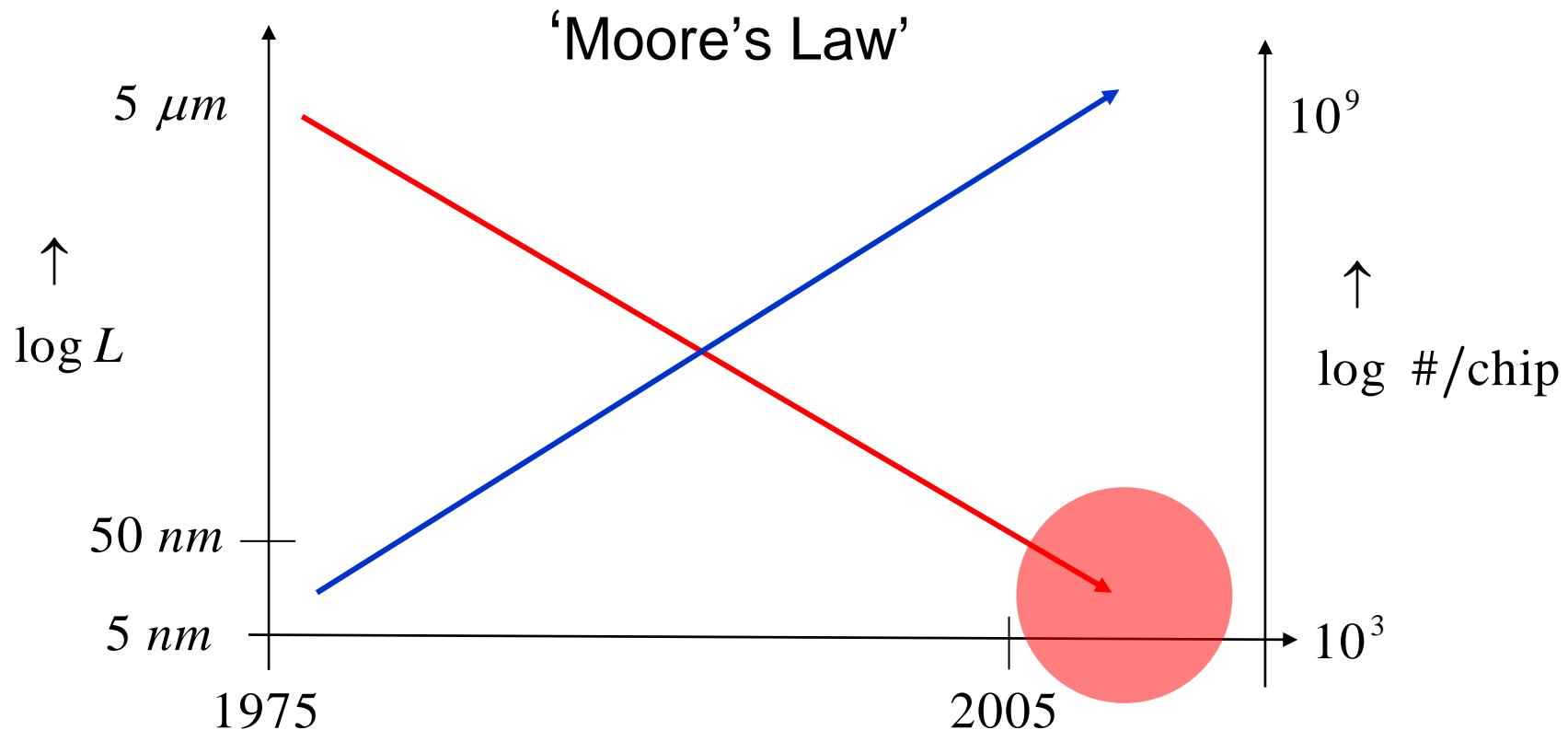
# IV characteristic: real



circuit schematic

(Courtesy, Shuji Ikeda, ATDF, Dec. 2007)

# MOSFET technology evolution



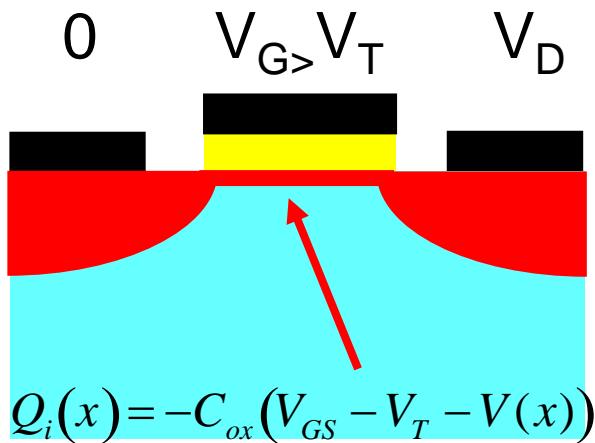
see: <http://www.intel.com/technology/mooreslaw/index.htm>

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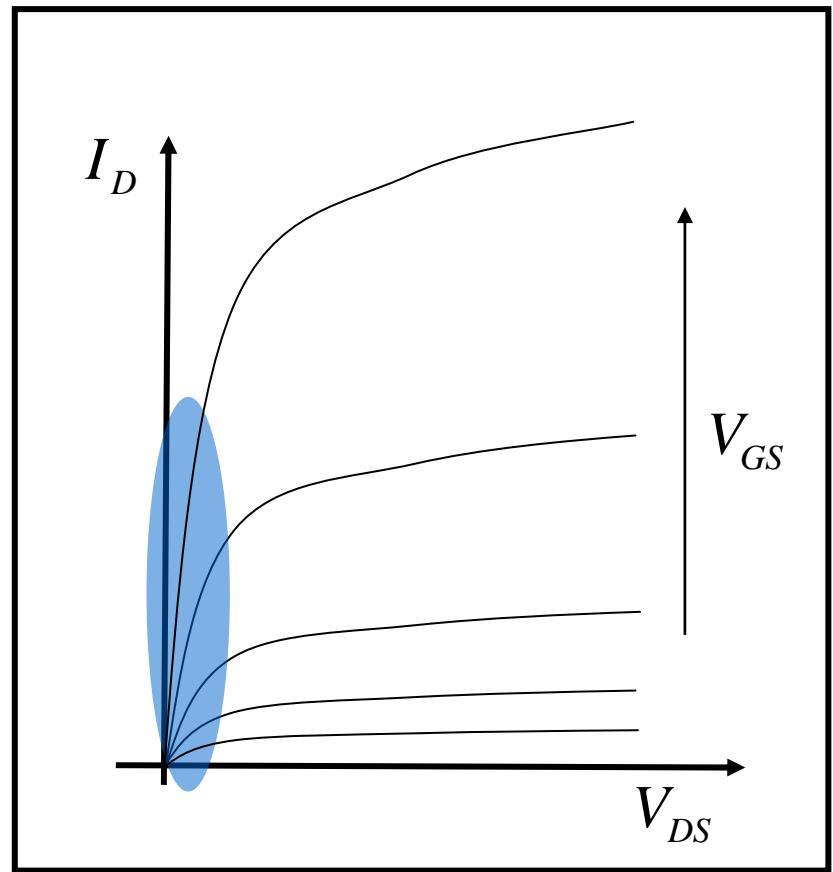
# MOSFET IV: low $V_{DS}$



$$I_D = W Q_i(x) v_x(x)$$

$$I_D = W C_{ox} (V_{GS} - V_T) \mu_{eff} \mathcal{E}_x$$

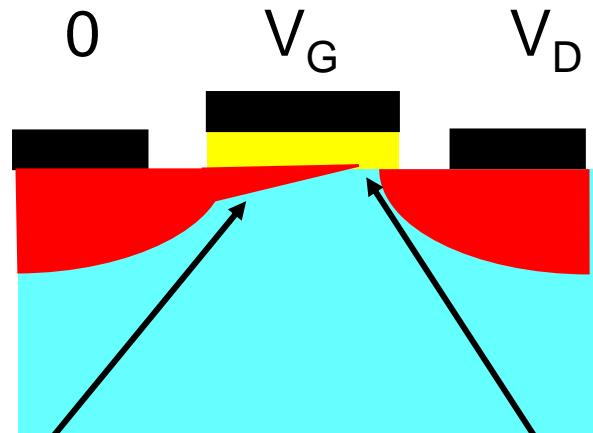
$$\mathcal{E}_x = \frac{V_{DS}}{L}$$



$$I_D = \frac{W}{L} \mu_{eff} C_{ox} (V_{GS} - V_T) V_{DS}$$

# MOSFET IV: ‘pinch-off’ at high $V_{DS}$

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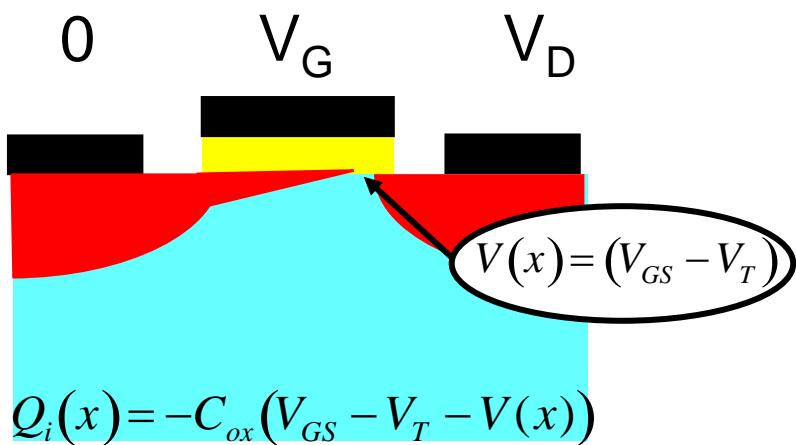


$$Q_i(x) = -C_{ox}(V_{GS} - V_T - V(x))$$

$$V(x) = (V_{GS} - V_T)$$

$$Q_i(x) \approx 0$$

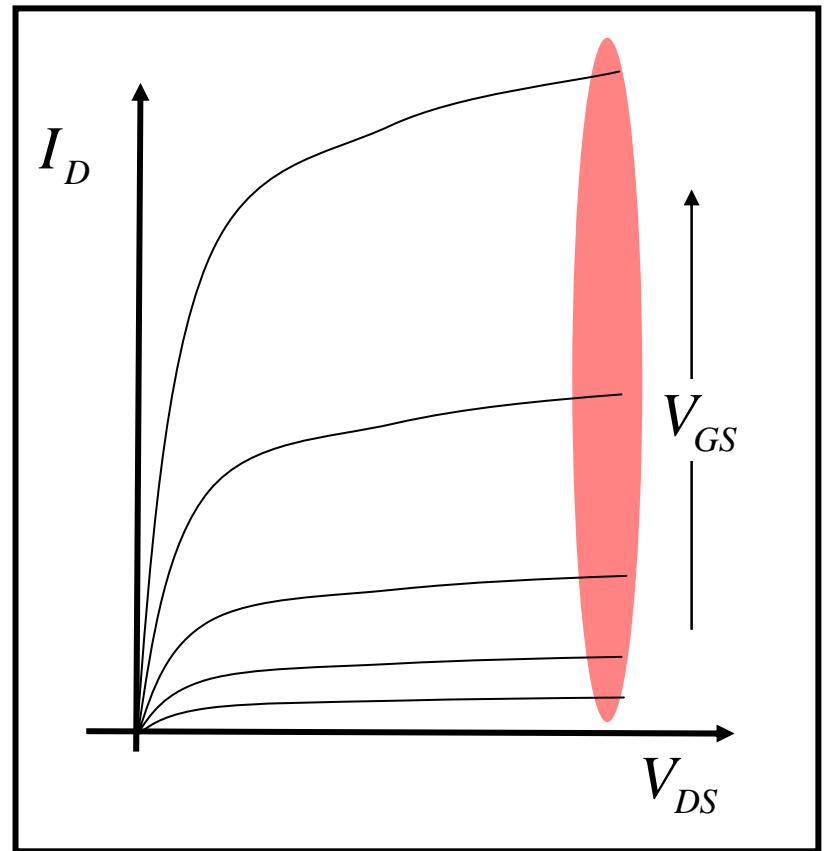
# MOSFET IV: high $V_{DS}$



$$I_D = W Q_i(x) v_x(x) = W Q_i(0) v_x(0)$$

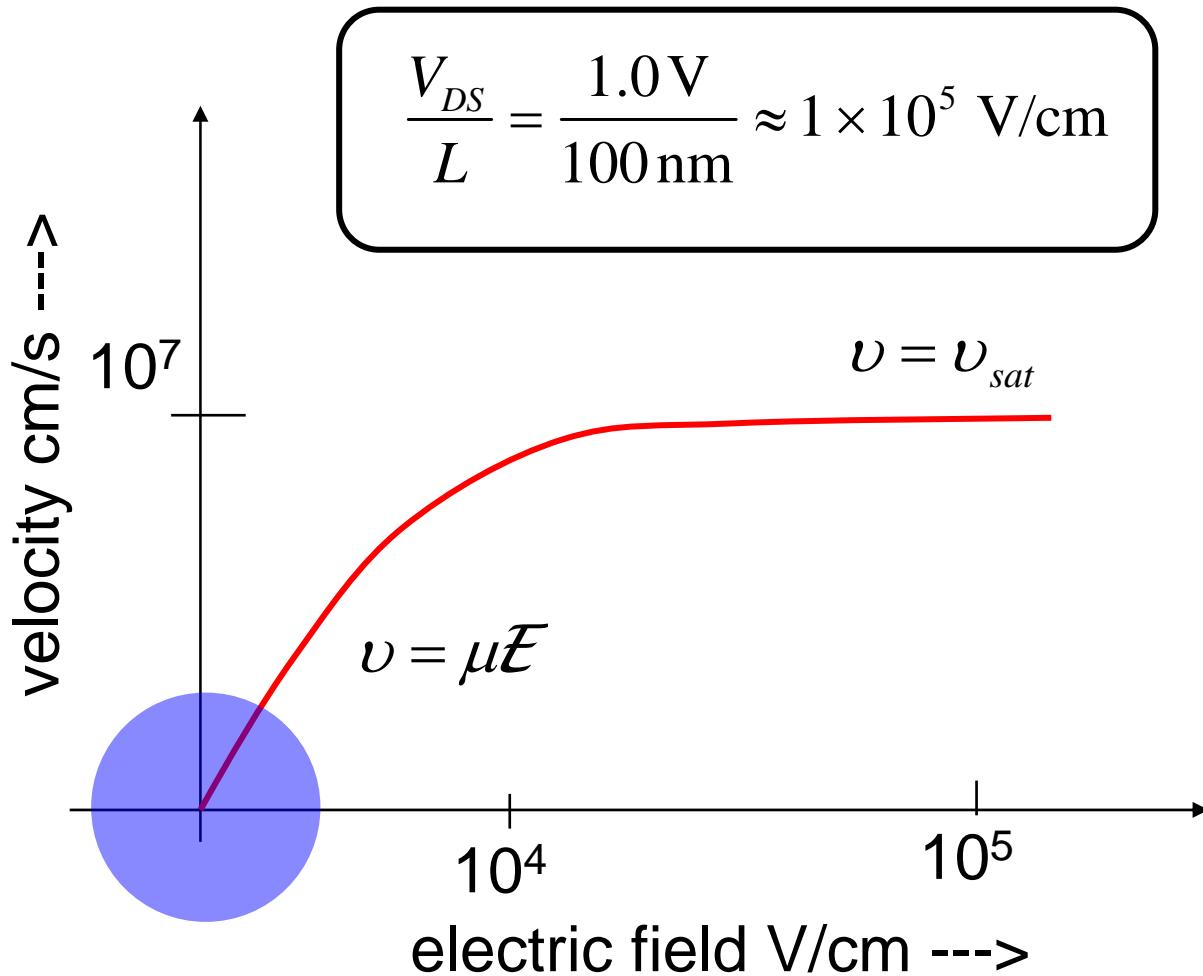
$$I_D = W C_{ox} (V_{GS} - V_T) \mu_{eff} \mathcal{E}_x(0)$$

$$\mathcal{E}_x(0) \approx \frac{V_{GS} - V_T}{L}$$

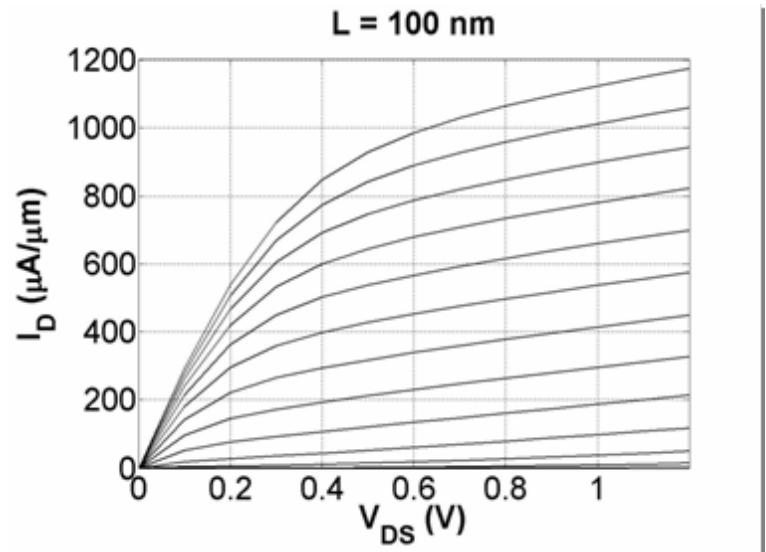
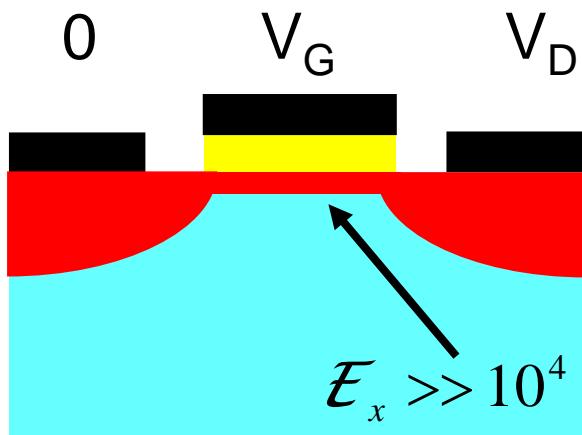


$$I_D = \frac{W}{2L} \mu_{eff} C_{ox} (V_{GS} - V_T)^2$$

# velocity saturation



# MOSFET IV: velocity saturation



(Courtesy, Shuji Ikeda, ATDF, Dec. 2007)

$$I_D = W Q_i(x) v_x(x)$$

$$I_D = W C_{ox} (V_{GS} - V_T) v_{sat}$$

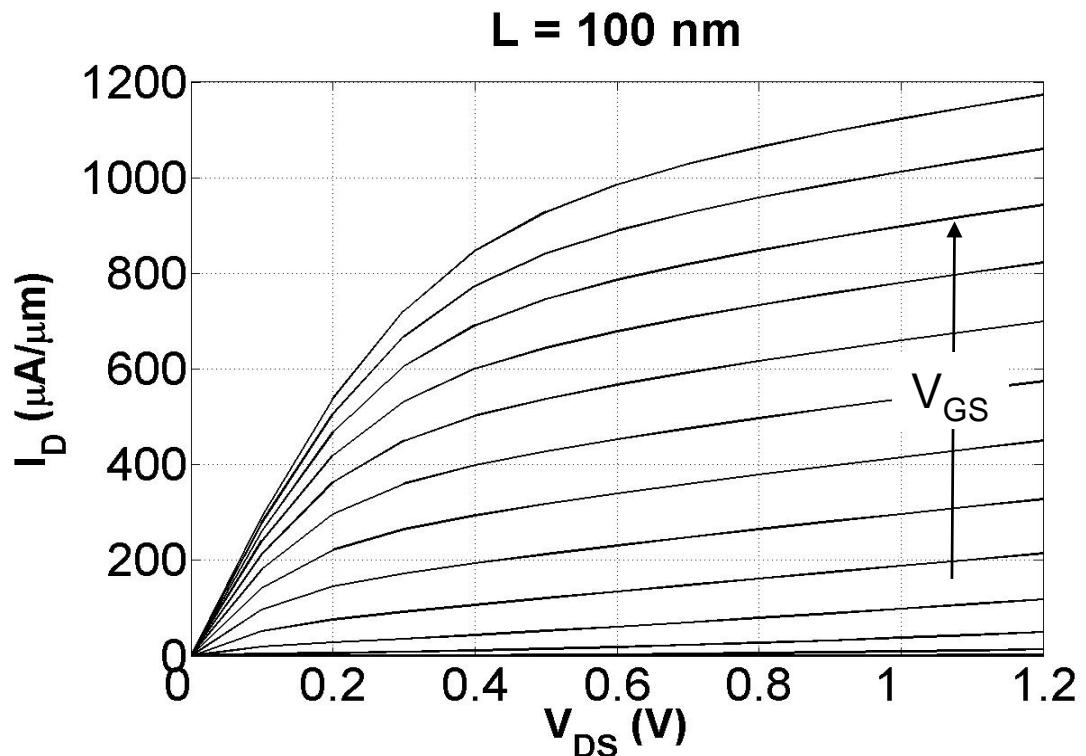
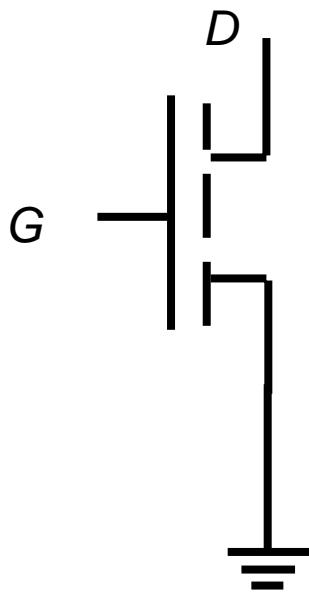
$$I_D = W C_{ox} v_{sat} (V_{GS} - V_T)$$

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# common source characteristics

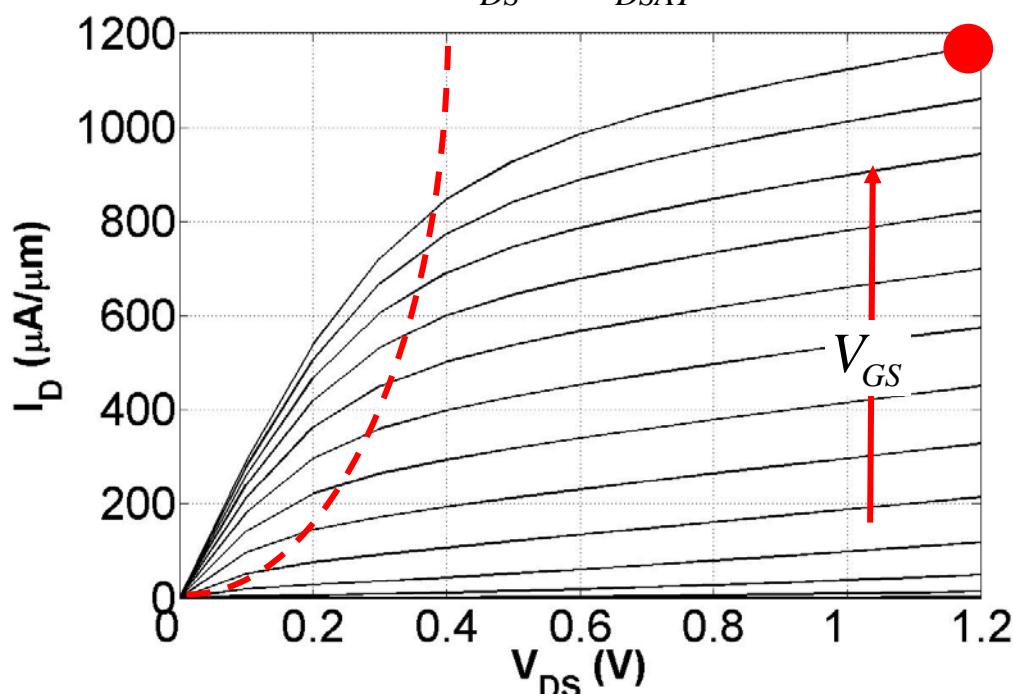


- 1) ground source ( $V_S = 0$ )
- 2) set  $V_G$
- 3) sweep  $V_D$  from 0 to  $V_{DD}$
- 4) step  $V_G$  from 0 to  $V_{DD}$

# common source characteristics

$$V_{DS} \ll V_{DSAT}$$

'linear region  
of operation'



$$I_{DS} (V_{GS} = V_{DD}, V_{DS} = V_{DD})$$

$$I_{DSAT} : (V_{GS} - V_T)^\alpha$$

$\alpha = 2$  ('square law')

$\alpha = 1$  ('velocity saturated')

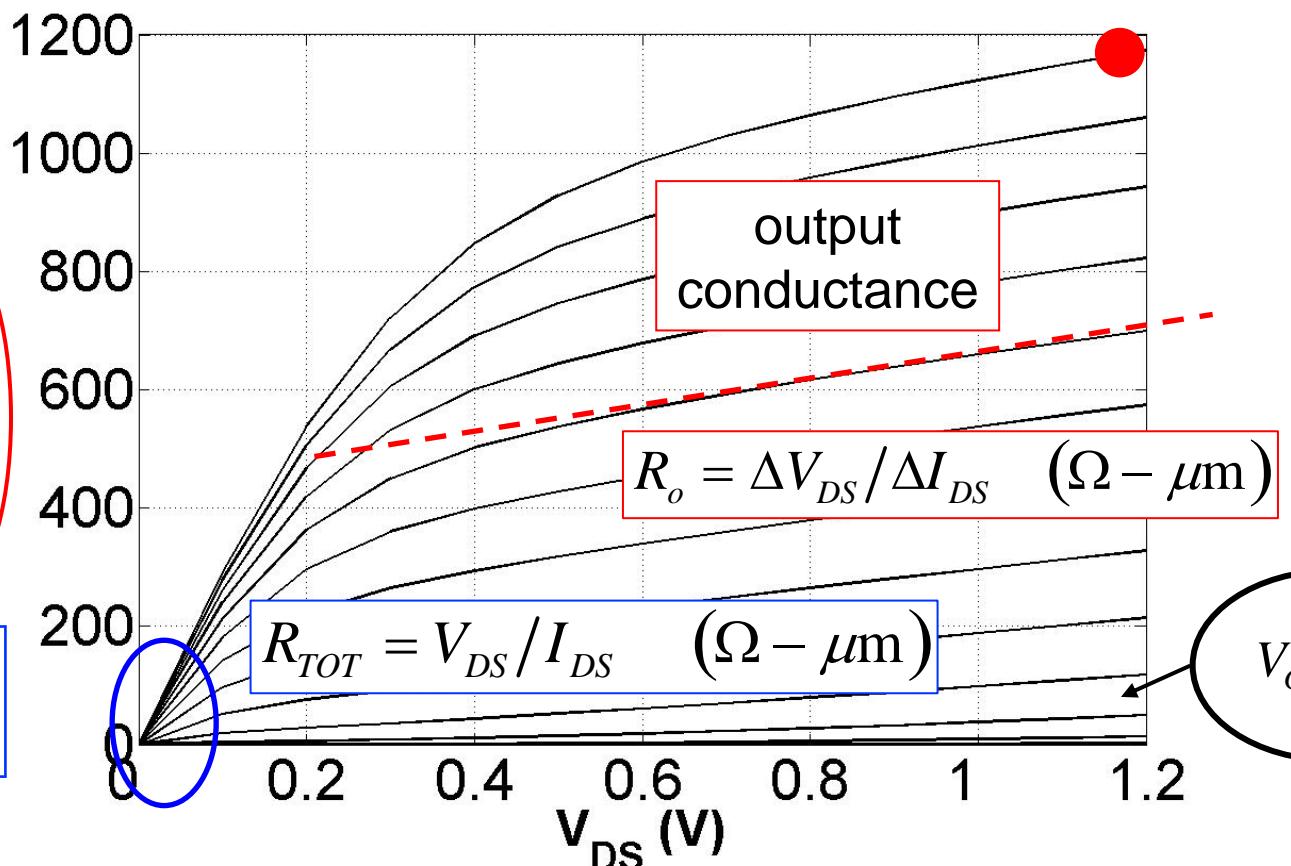
$V_{DS} \gg V_{DSAT}$   
'saturation region'  
('beyond pinch-off')

# common source characteristics

currents typically quoted  
per micrometer of  
MOSFET width,  $W$

$L = 100 \text{ nm}$

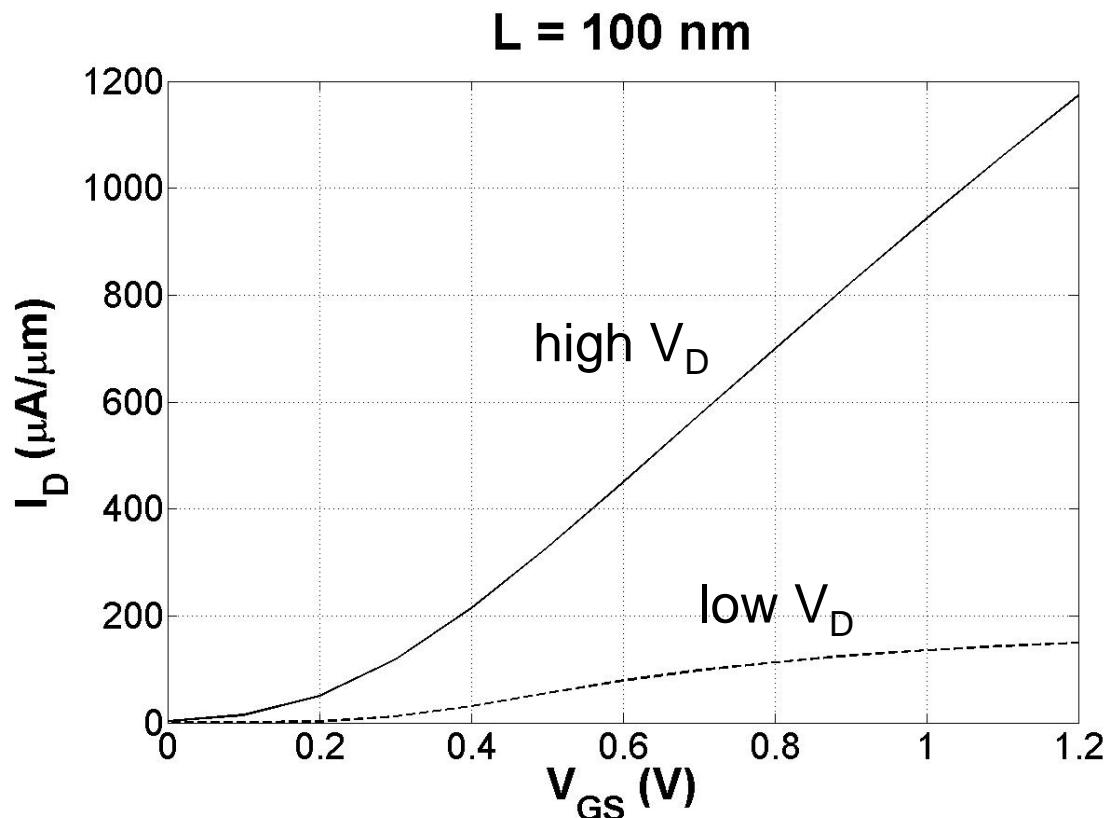
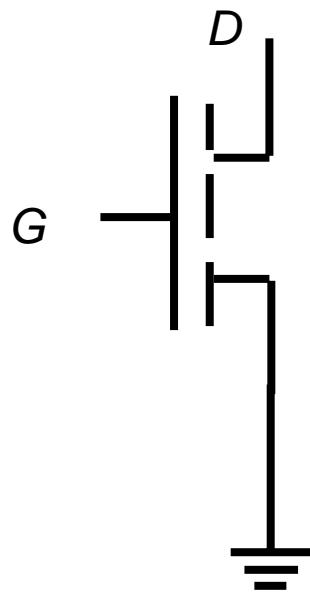
$I_{ON} (\mu\text{A}/\mu\text{m})$



channel  
resistance

$V_{GS} \approx V_T$

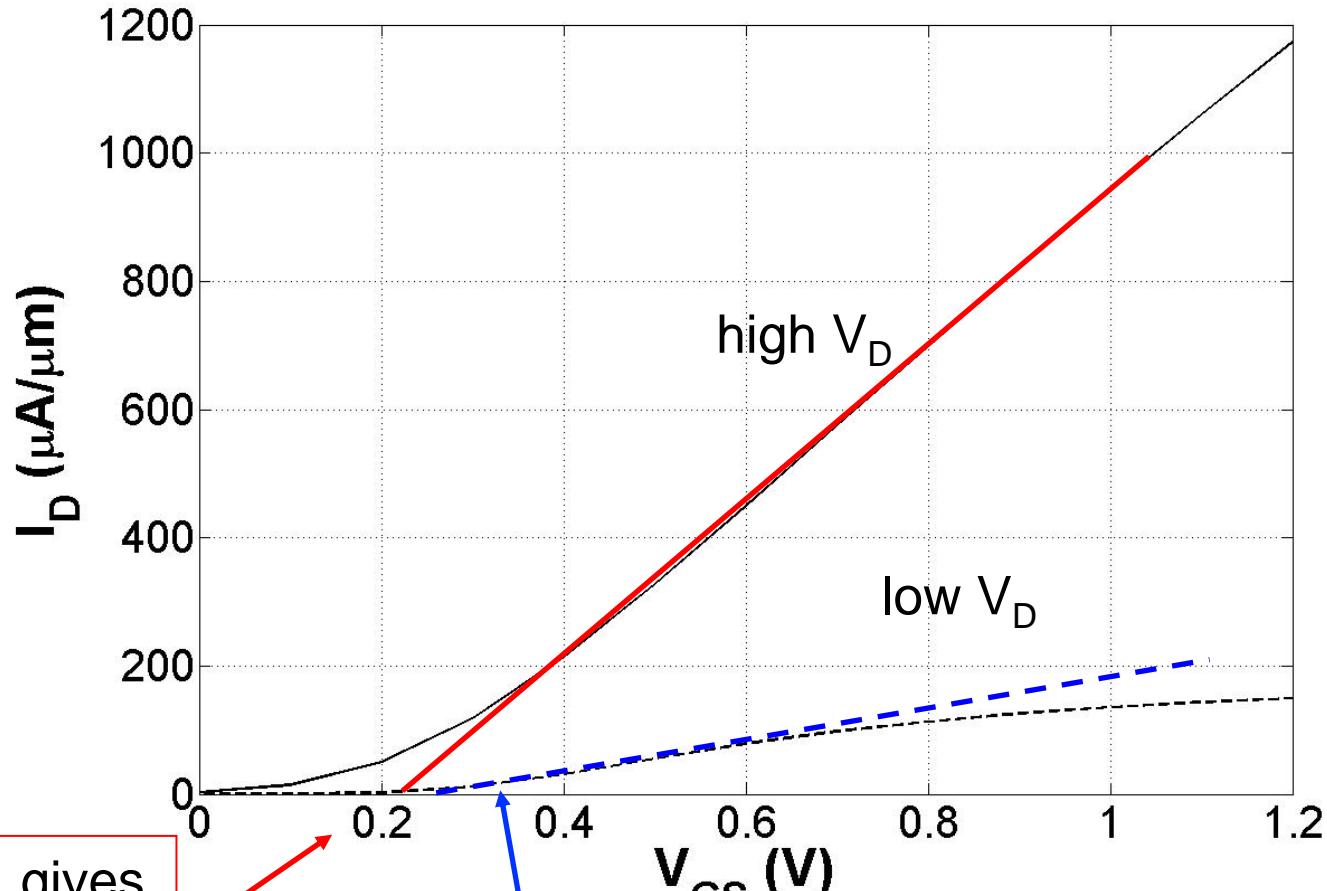
# transfer characteristics



- 1) ground source
- 2) set  $V_D$
- 3) sweep  $V_G$  from 0 to  $V_{DD}$

# measuring $V_T$

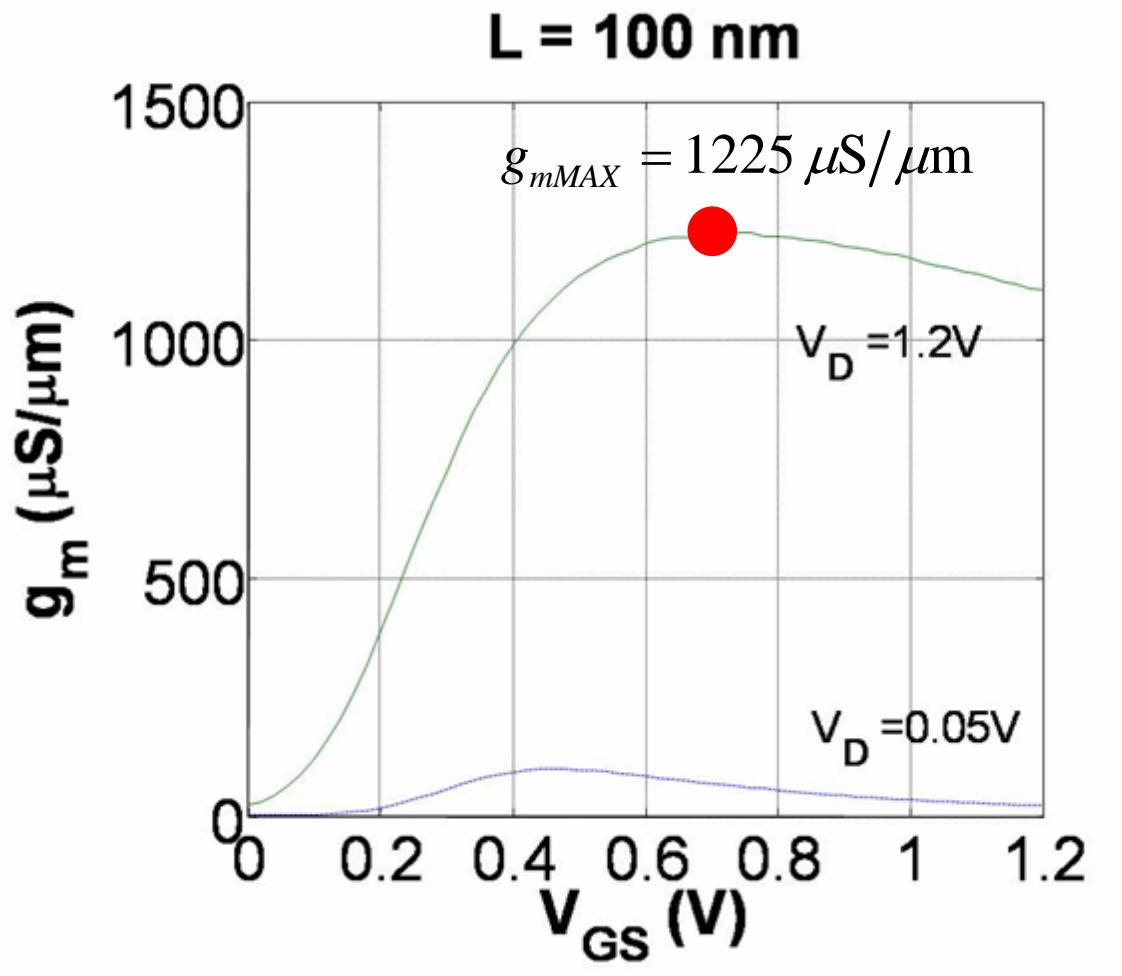
$L = 100 \text{ nm}$



intercept gives  
 $V_T(\text{sat}) < V_T(\text{lin})$

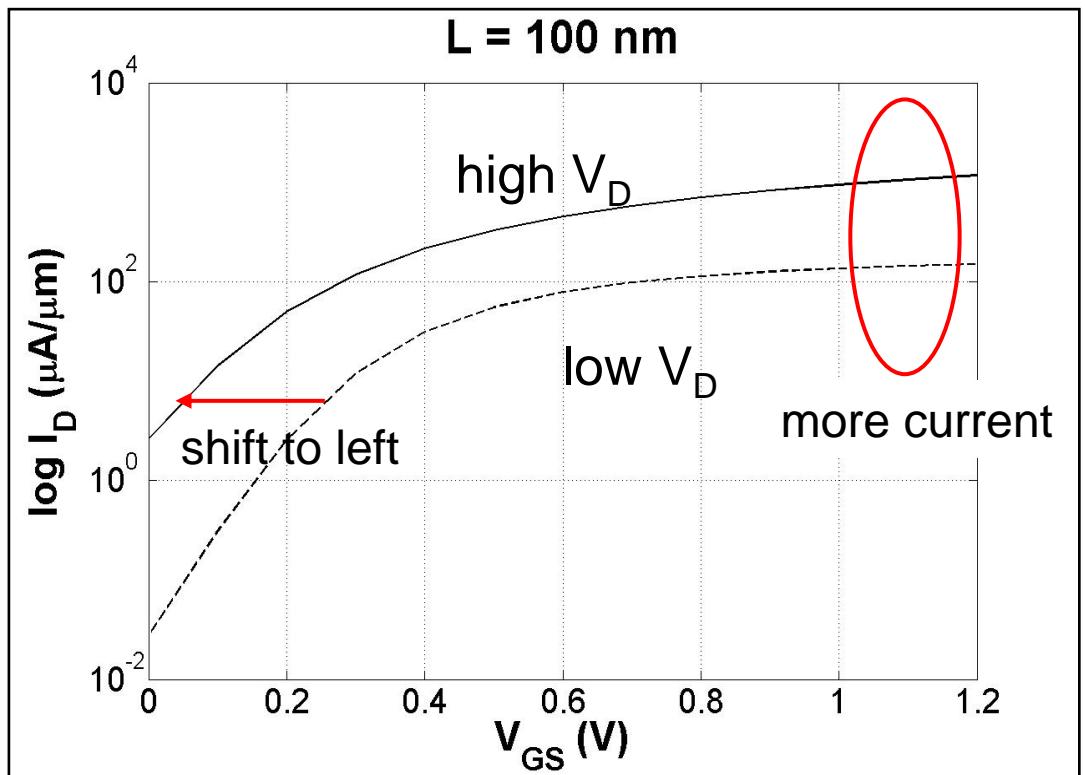
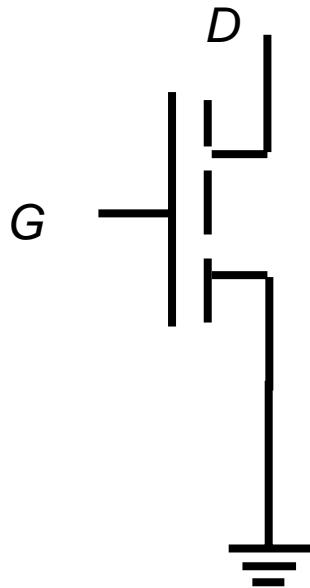
intercept gives  $V_T(\text{lin})$   
slope is related to the effective mobility

# transconductance



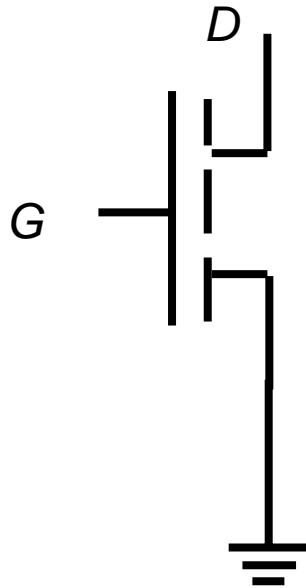
$$g_m \equiv \left. \frac{\partial I_{DS}}{\partial V_{GS}} \right|_{V_{DS}}$$

# $\log_{10} I_D$ vs. $V_{GS}$

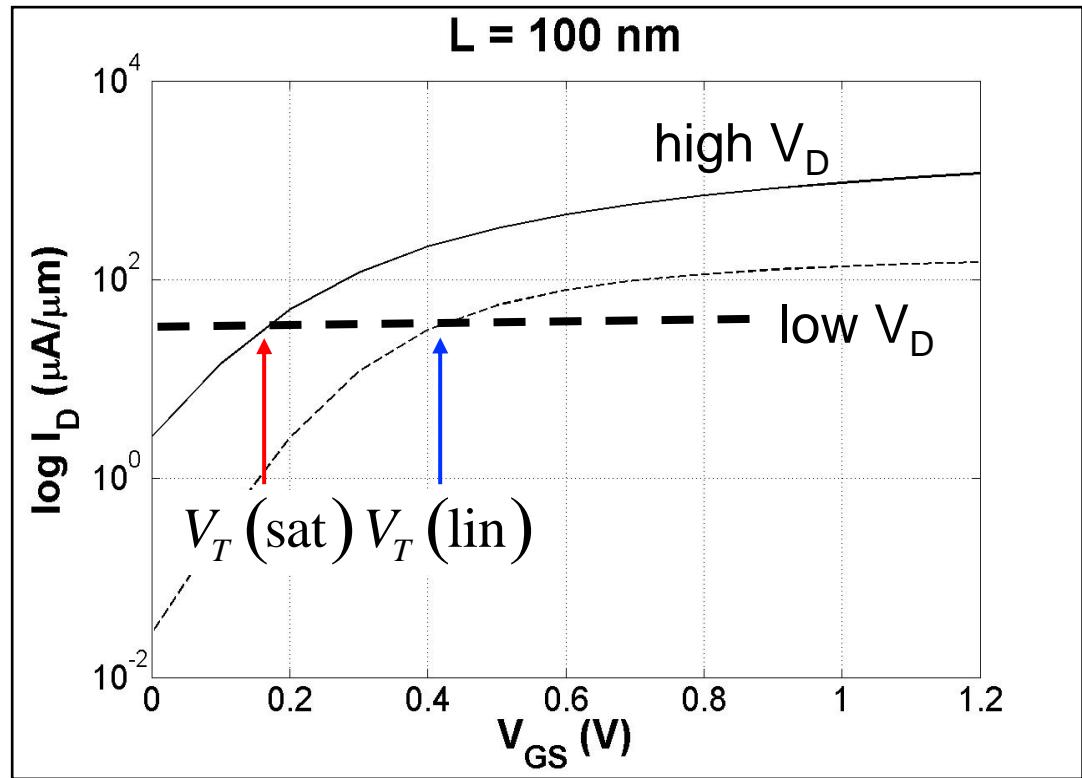


- 1) ground source
- 2) set  $V_D = V_{DD}$
- 3) sweep  $V_G$  from 0 to  $V_{DD}$

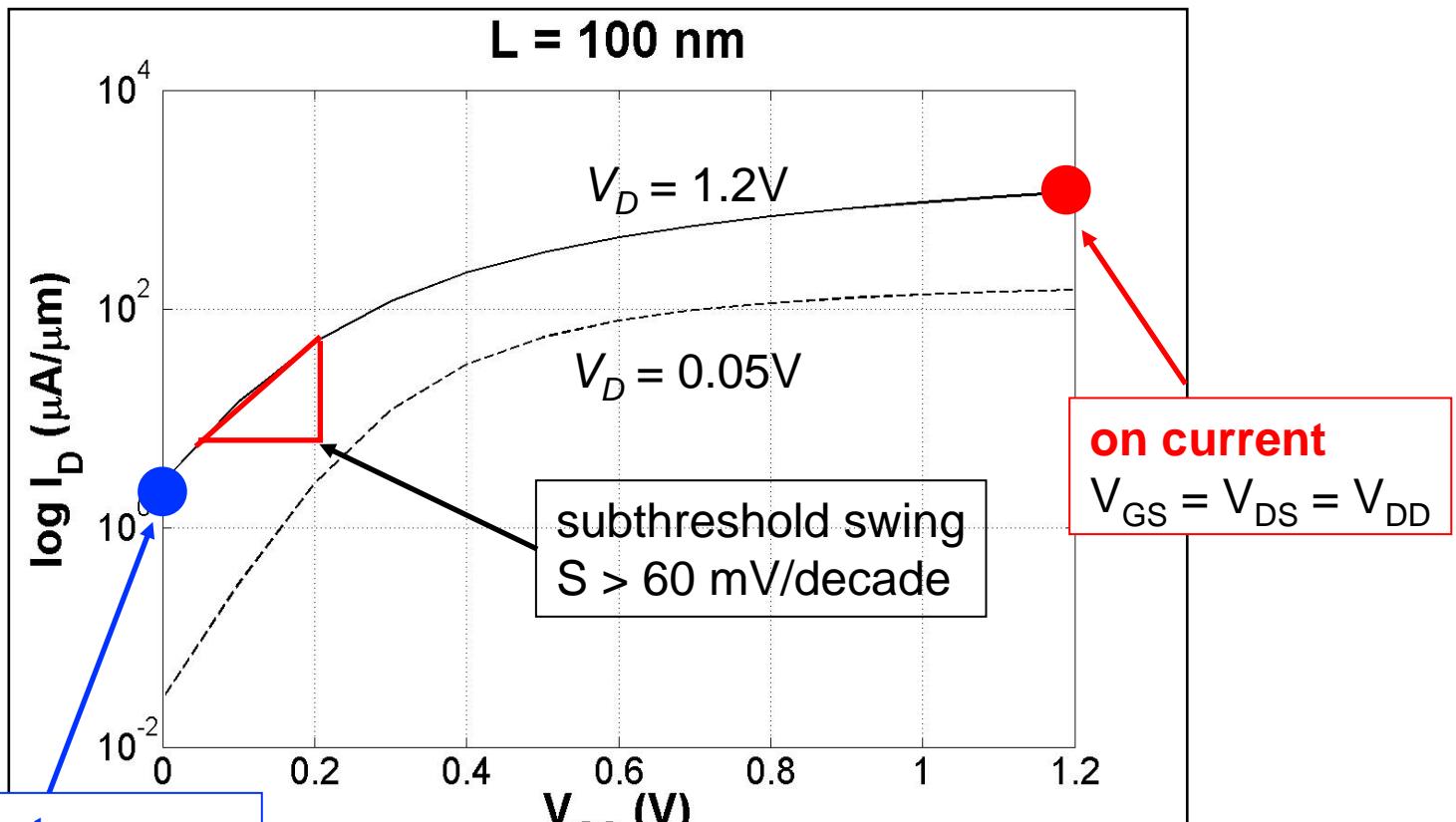
# another way to ‘measure’ $V_T$



- 1) ground source
- 2) set  $V_D = V_{DD}$
- 3) sweep  $V_G$  from 0 to  $V_{DD}$

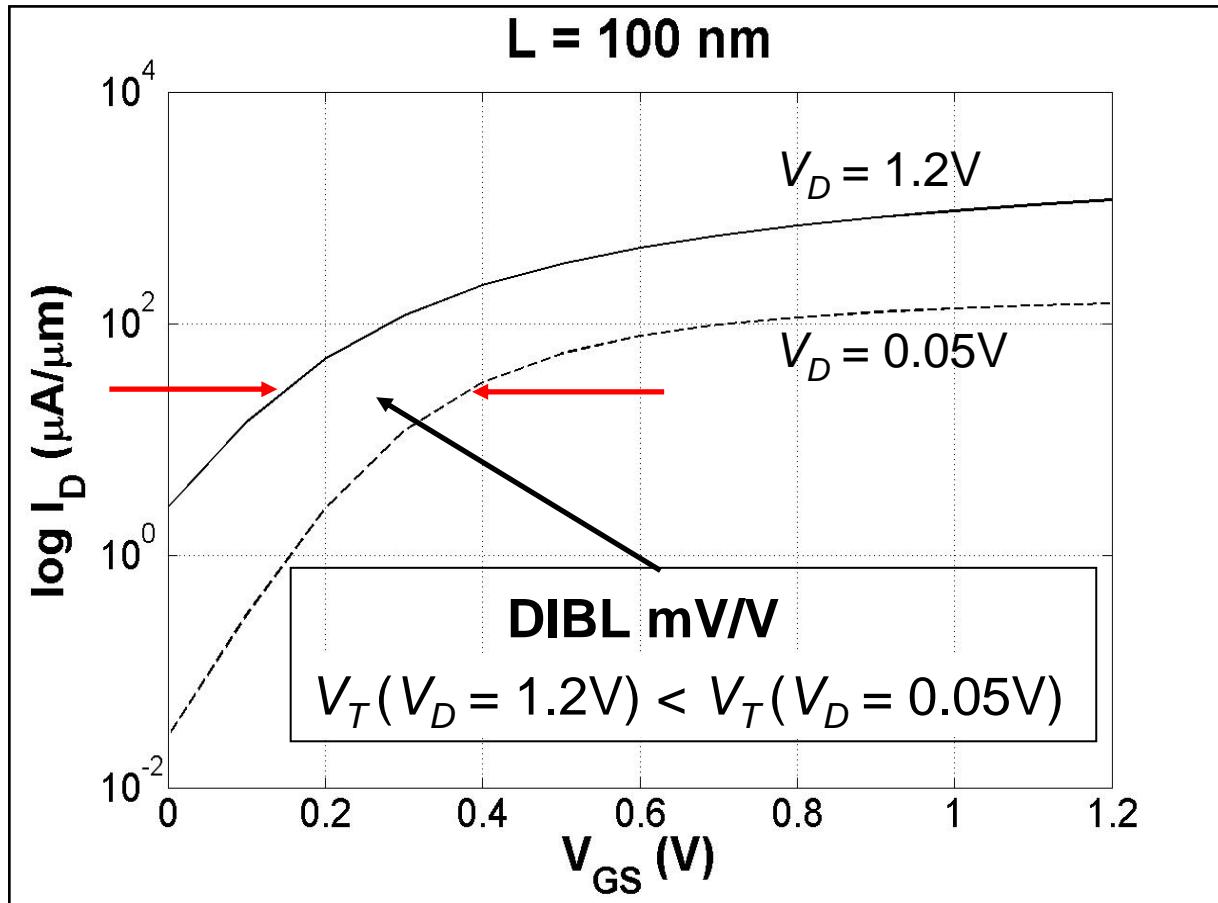


# $\log_{10} I_D$ vs. $V_{GS}$



$S$  is the number of millivolts required to increase  $V_G$  to produce a factor of 10 increase in  $I_D$  (in the sub-threshold region).

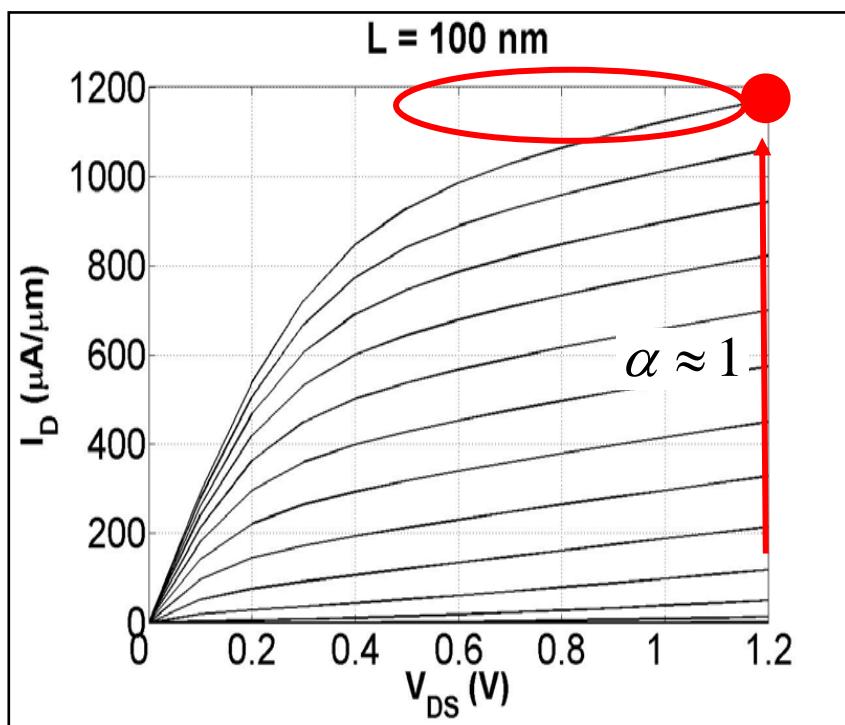
# DIBL (drain-induced barrier lowering)



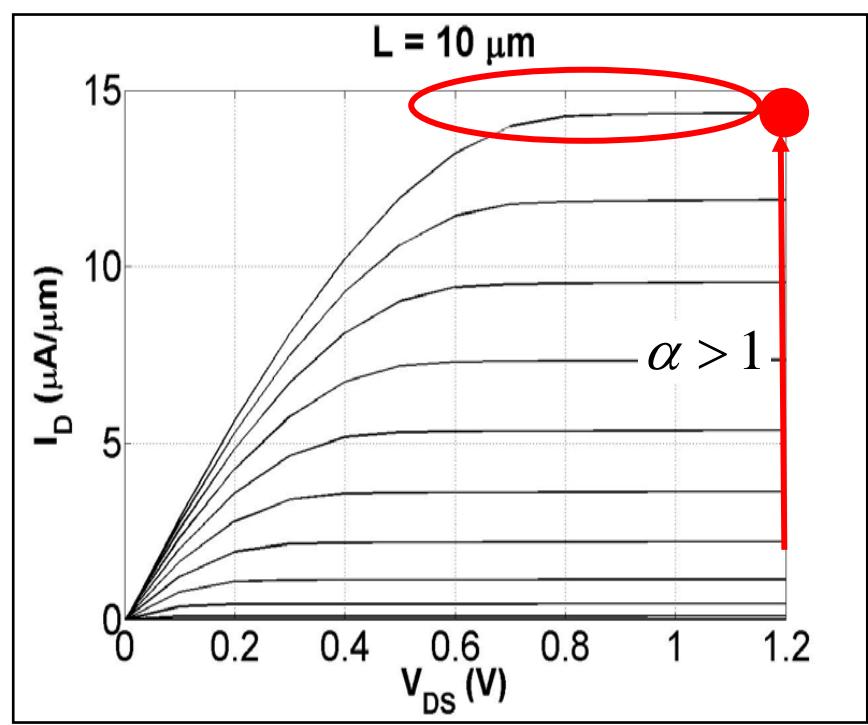
*DIBL* is the horizontal shift in the subthreshold characteristic (in millivolts) divided by the change in  $V_D$  (in volts).

# long channel vs. short channel

$L = 100\text{nm}$



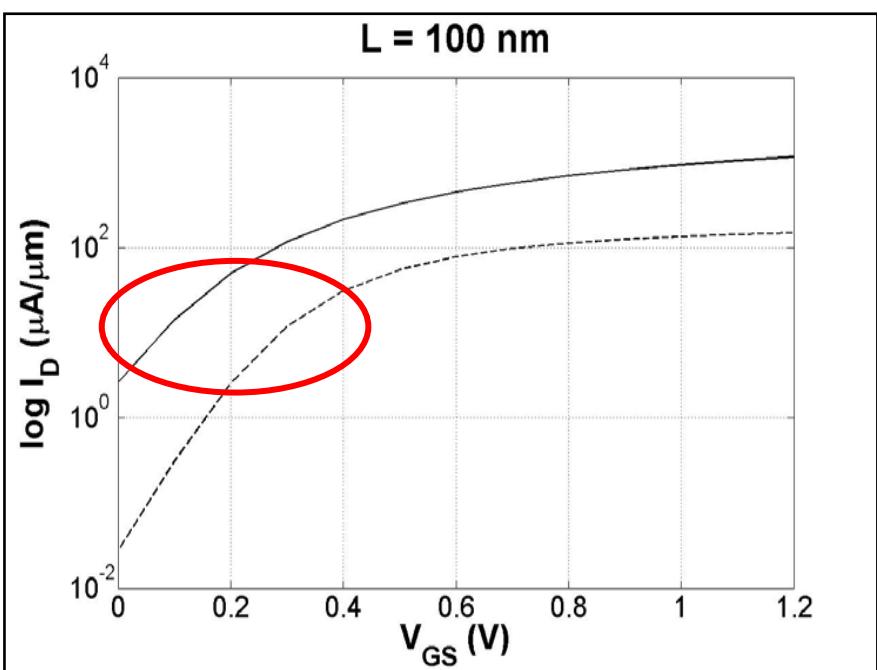
$L = 10\text{ }\mu\text{m}$  (10,000 nm)



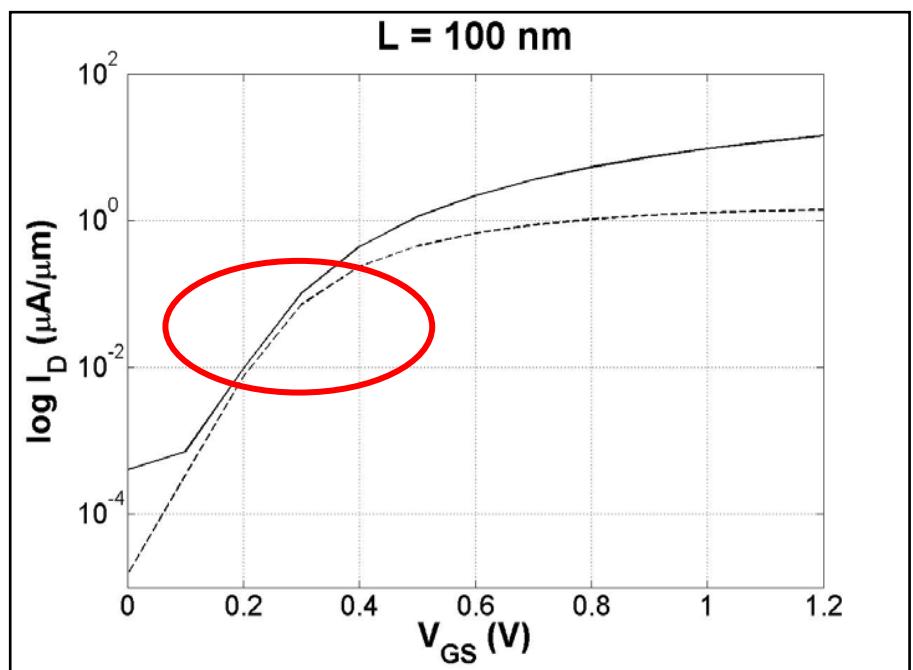
$$I_{DSAT} : (V_{GS} - V_T)^\alpha$$

# long channel vs. short channel

$L = 100\text{nm}$



$L = 10 \mu\text{m}$  (10000 nm)



# device performance metrics summary

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You should now be familiar with the following terms:

- 1) On-current
- 2) Off-current
- 3) Channel resistance
- 4) Output resistance
- 5) Threshold voltage
- 6) Drain saturation voltage
- 7) Subthreshold swing  $S$  (mV/dec)
- 8) Drain Induced Barrier Lowering DIBL (mV/V)

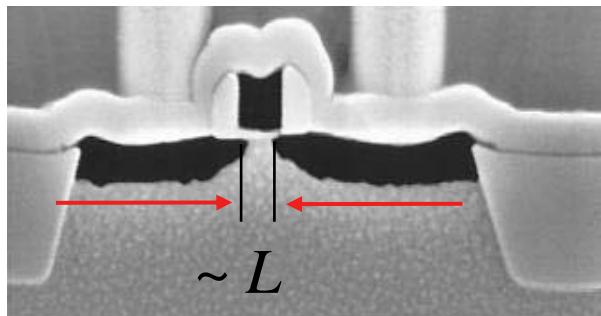
# outline

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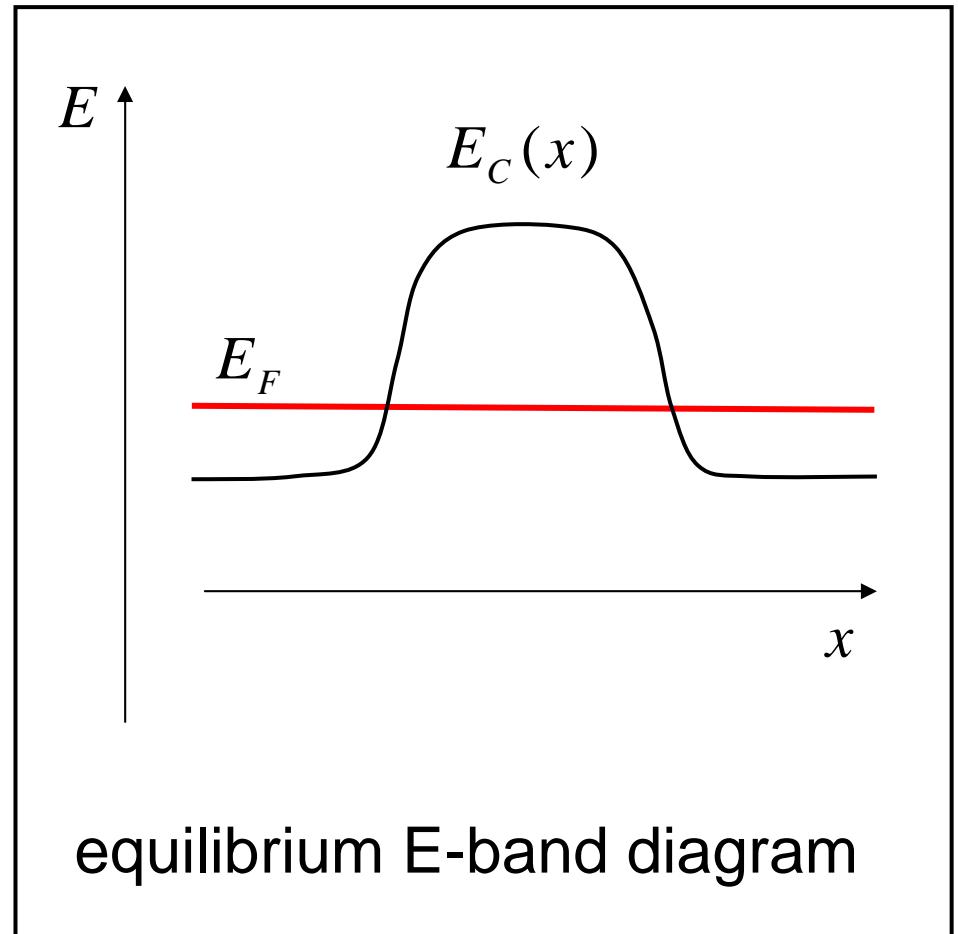
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# energy vs. position

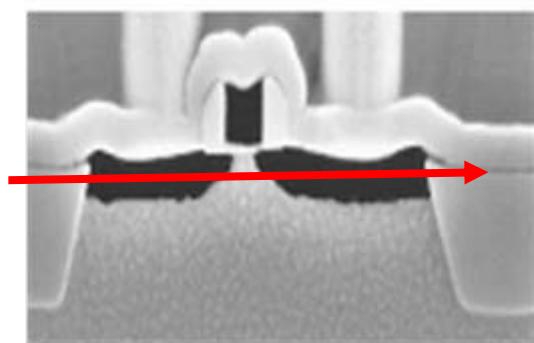
source gate drain



physical structure

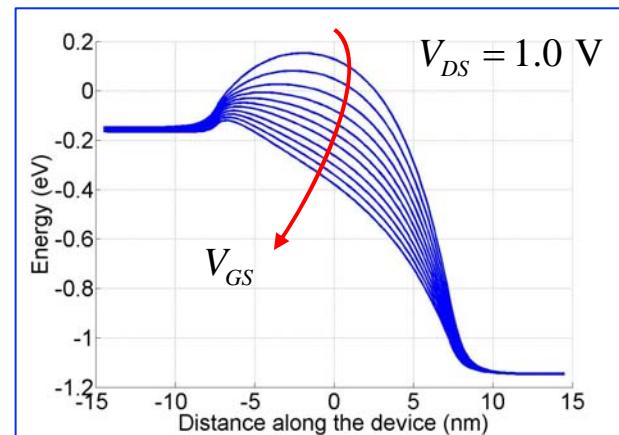
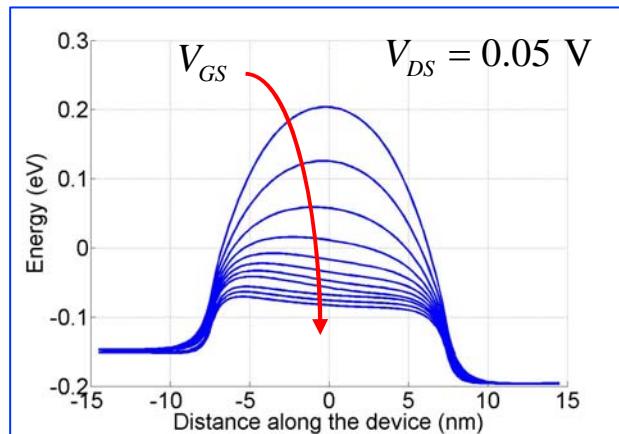


# controlling current with energy barriers



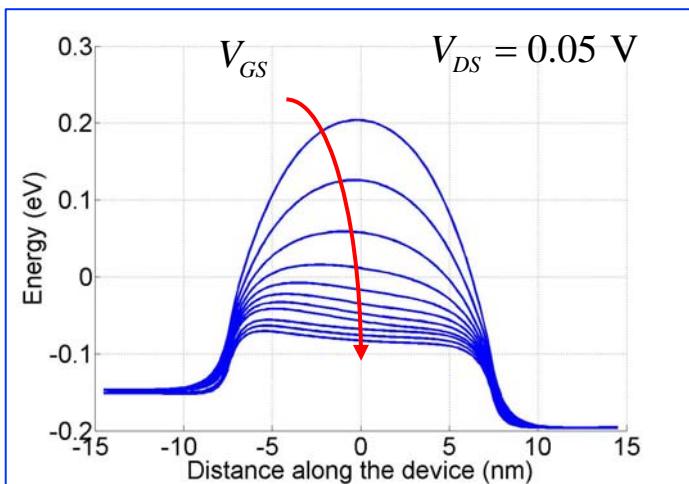
$$E = -qV$$

*electron energy vs. position*

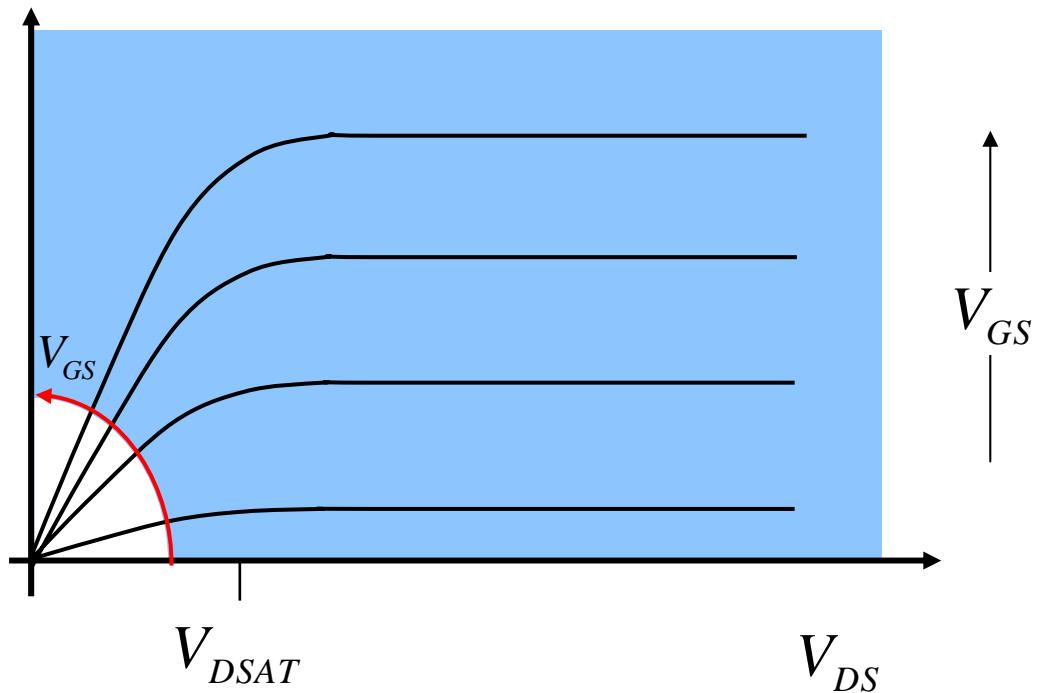


# low $V_{DS}$

$$I^+ \quad I^-$$

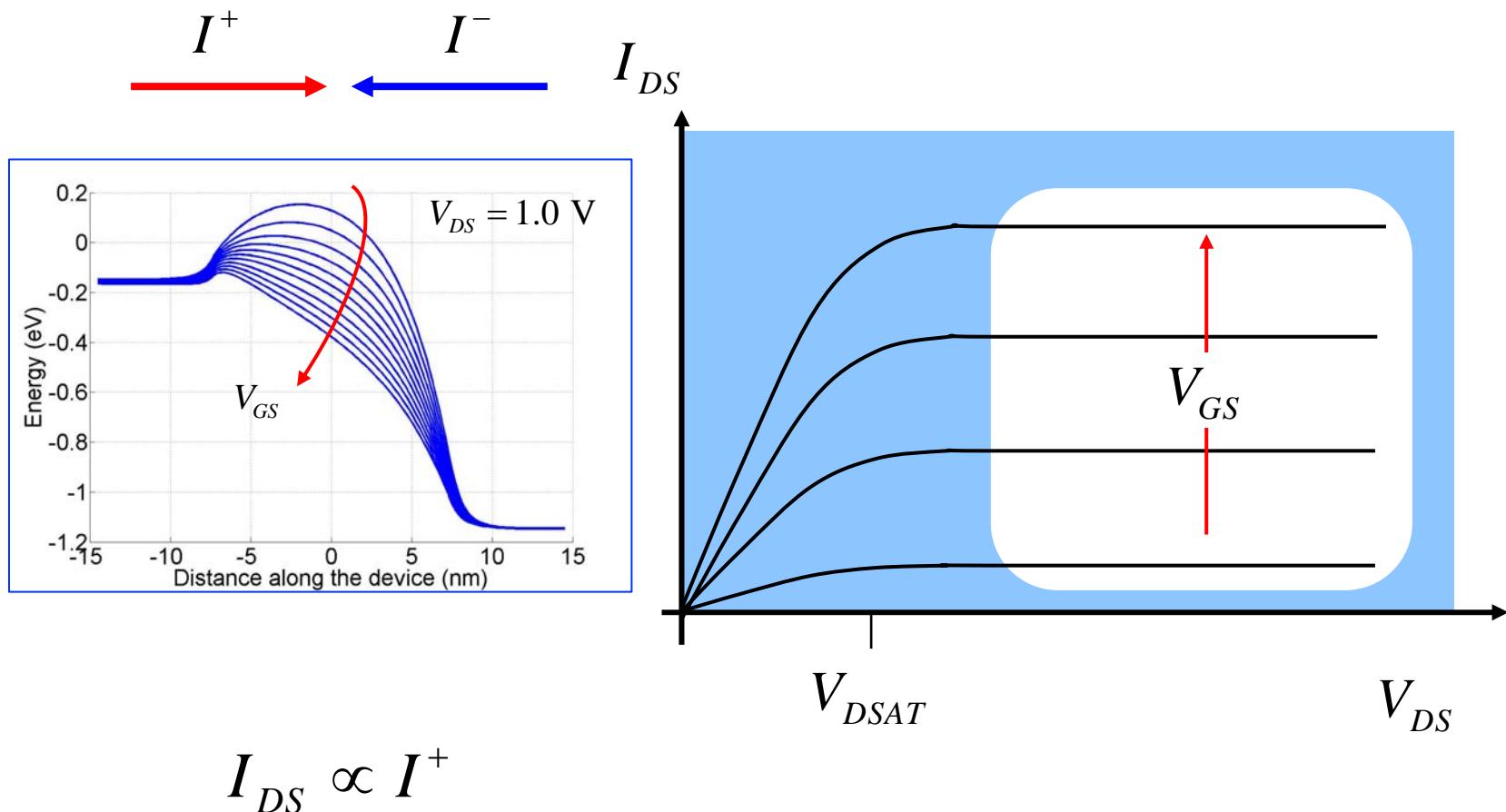


$$I_{DS}$$



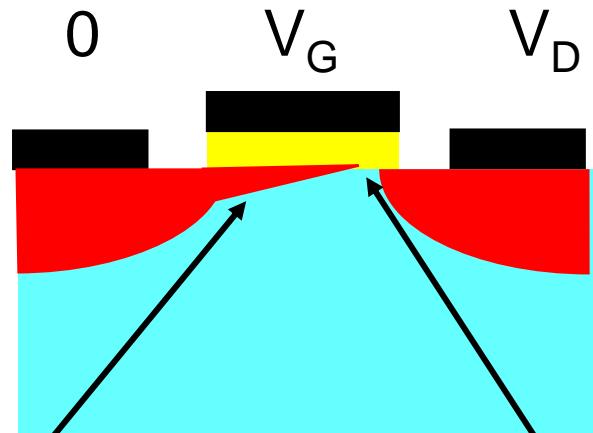
$$I^+ - I^- \propto V_{DS}$$

# high $V_{DS}$



# MOSFET IV: pinch-off at high $V_{DS}$

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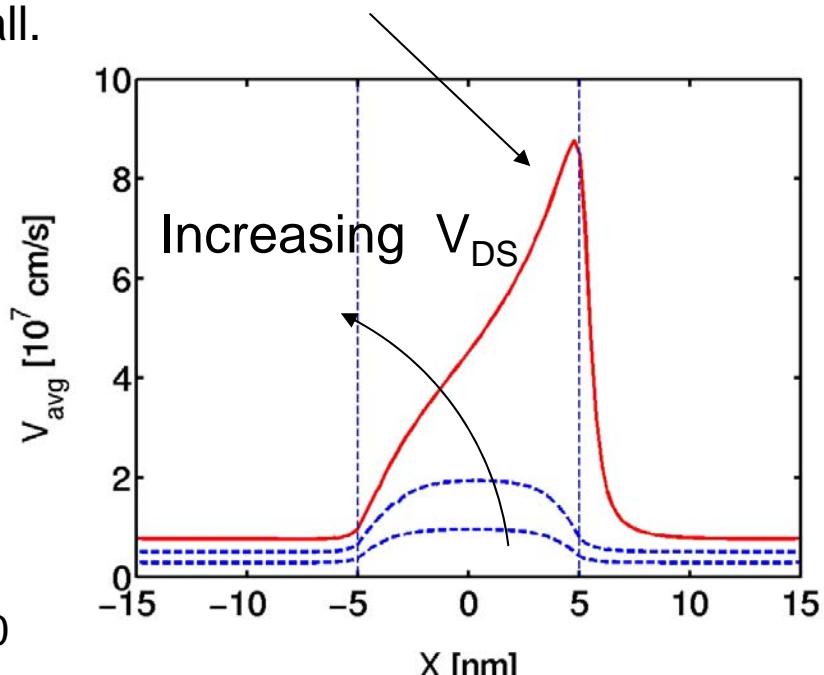
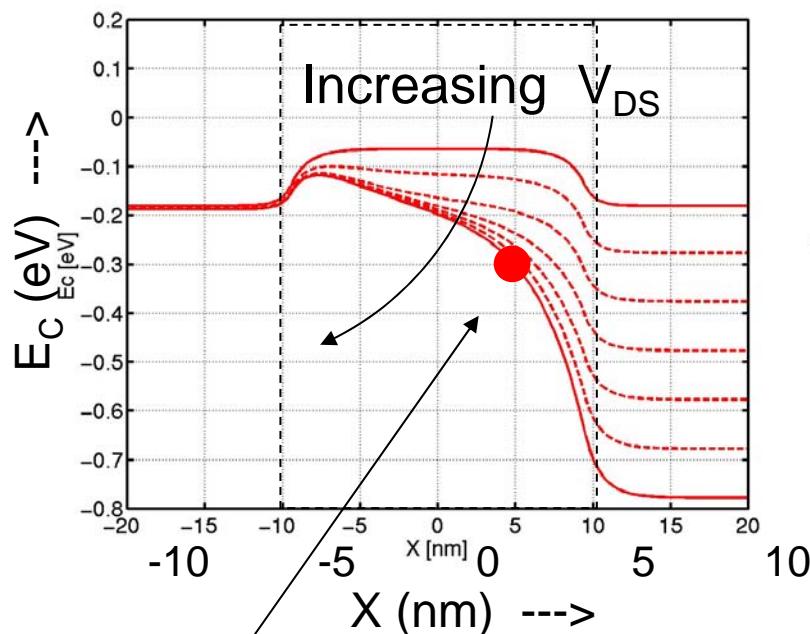
$$Q_i(x) = -C_{ox}(V_{GS} - V_T - V(x))$$

$$V(x) = (V_{GS} - V_T)$$

$$Q_i(x) \approx 0$$

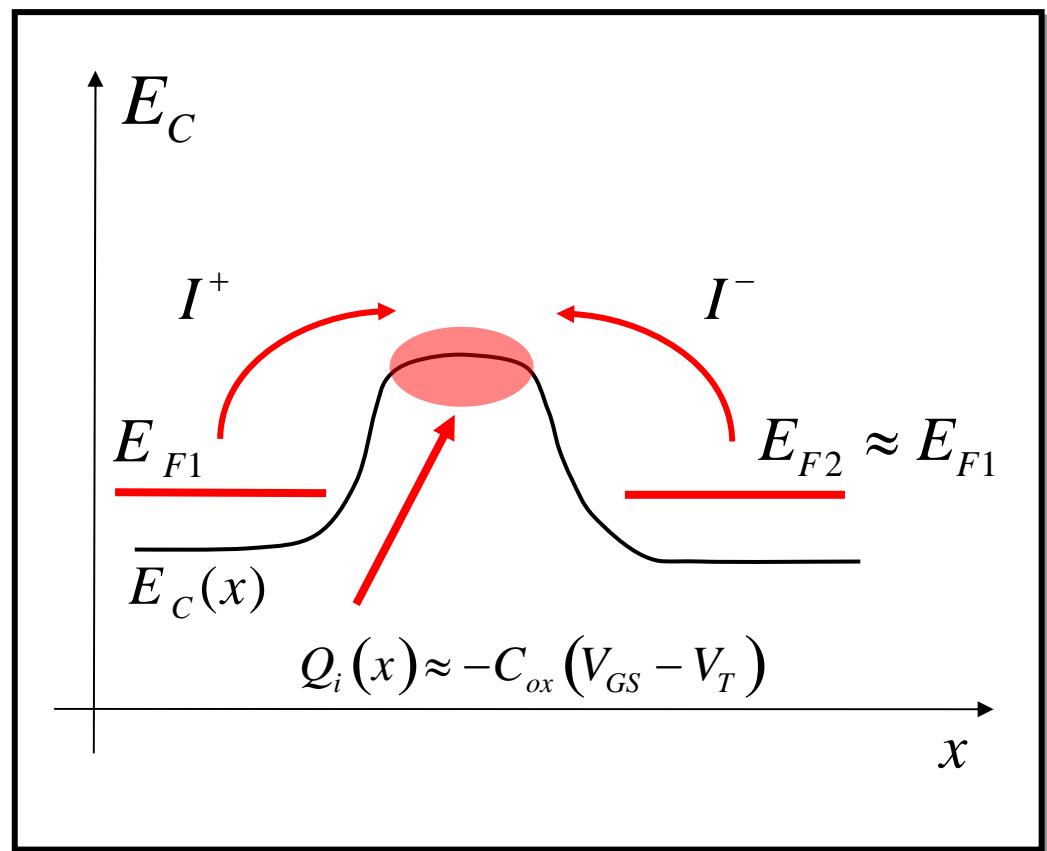
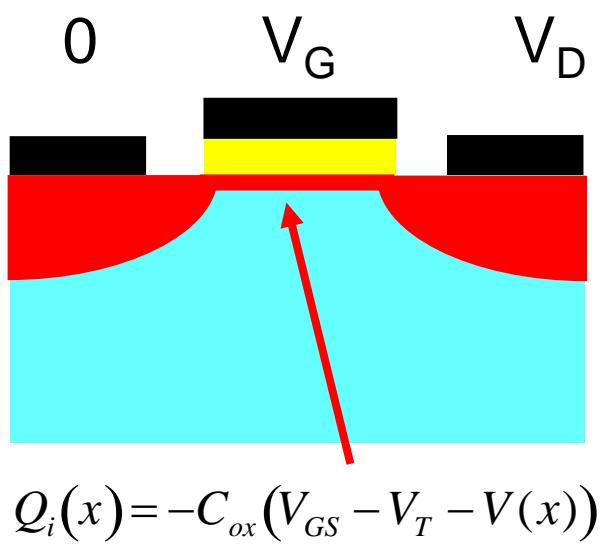
# pinch off in a MOSFET

The electron velocity is very high in the pinch-off region. High velocity implies low inversion layer density (because  $I_D$  is constant). In the textbook model, we say  $Q_i \approx 0$ , but it is not really zero - just very small.

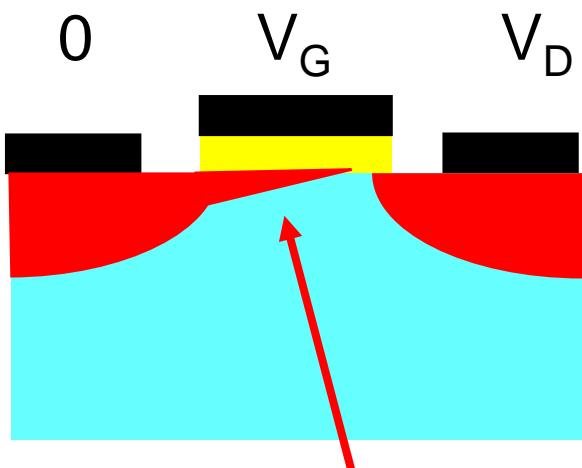


**pinch-off point:** where the electric field along the channel becomes very large. Note that electrons are simply swept across the high-field (pinched-off) portion at very high velocity.

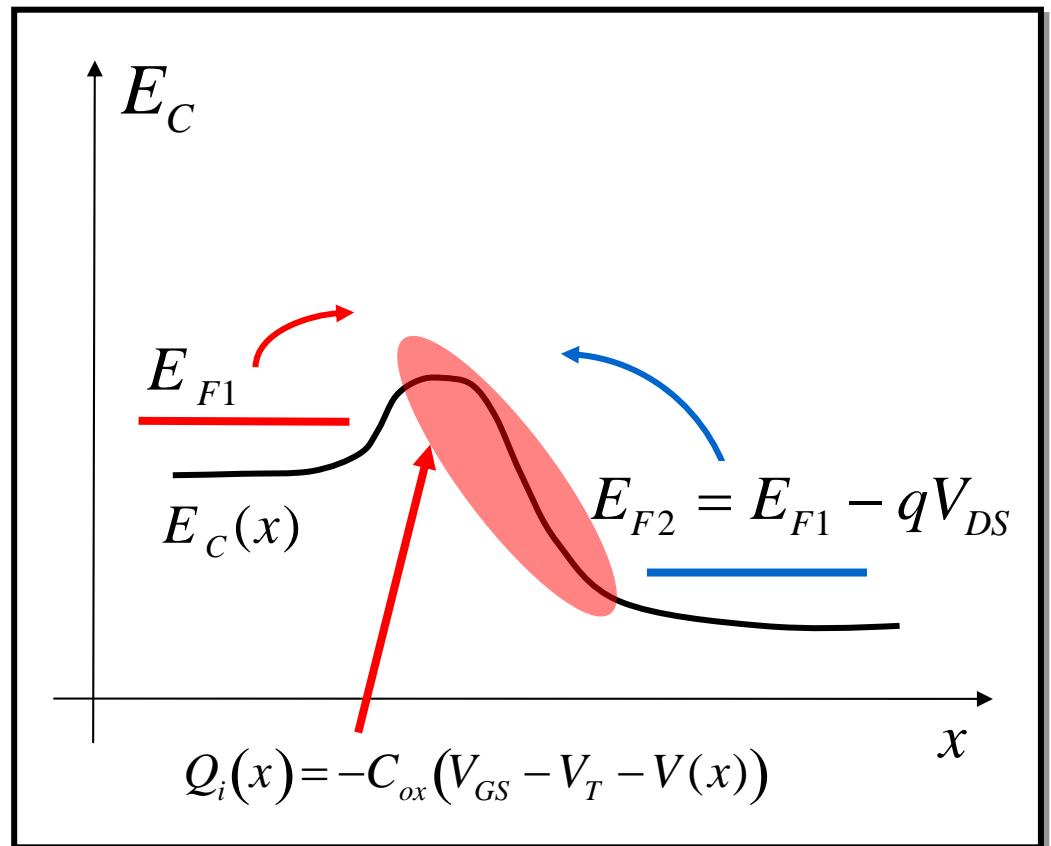
# barrier-controlled vs. charge controlled view



# barrier-controlled vs. charge controlled view

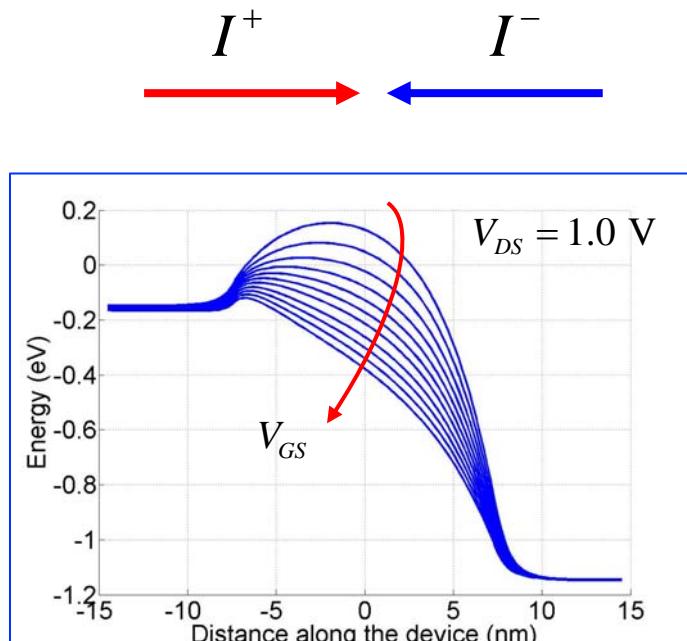


$$Q_i(x) = -C_{ox}(V_{GS} - V_T - V(x))$$

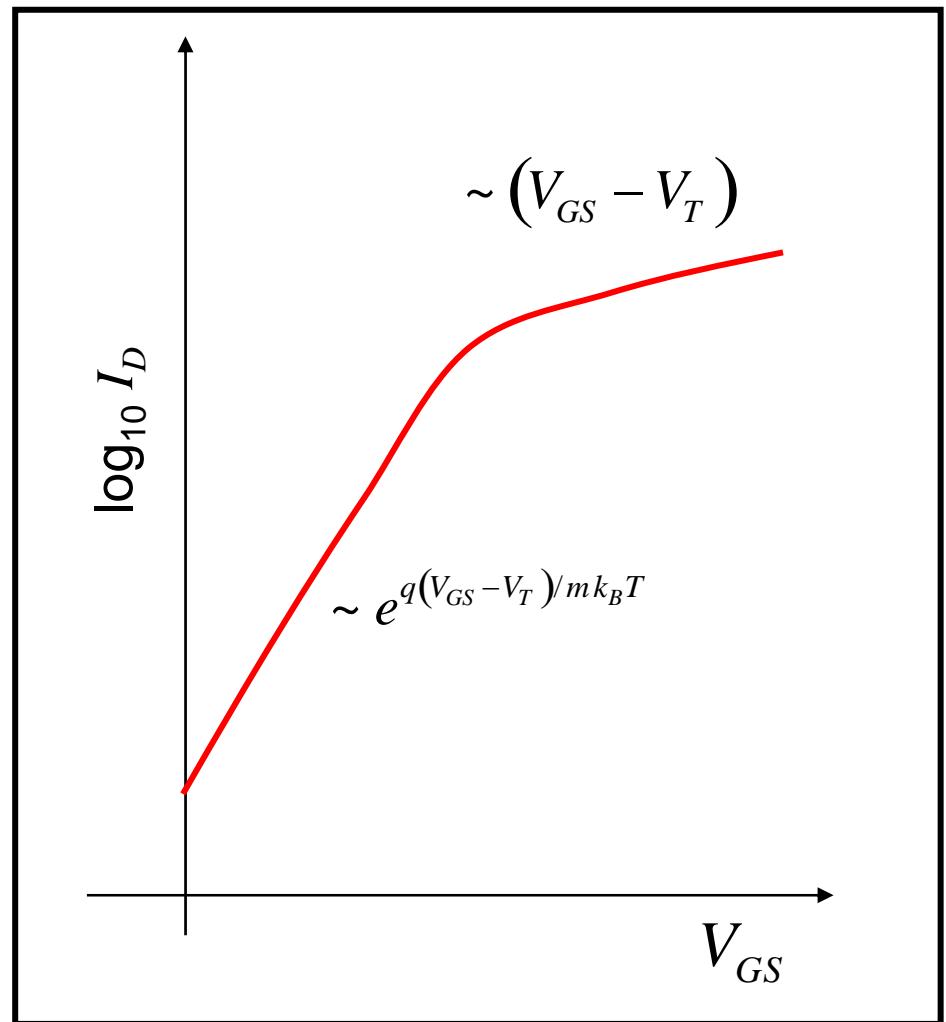


$$Q_i(x) = -C_{ox}(V_{GS} - V_T - V(x))$$

# IV characteristic for high $V_{DS}$



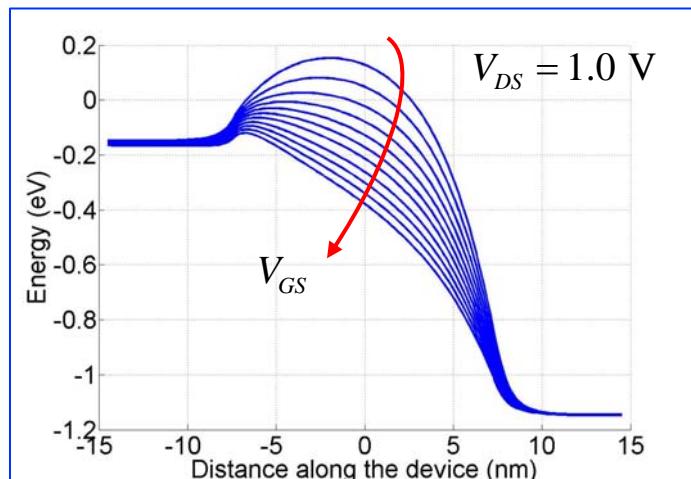
$$I_D \approx I^+$$



# IV characteristic for high $V_{DS}$ (below threshold)

$I^+$        $I^-$

Red arrow:  $I^+$   
Blue arrow:  $I^-$



$$I_D \approx I^+$$

$$I_D \approx I^+ \sim e^{-\Delta E/k_B T}$$

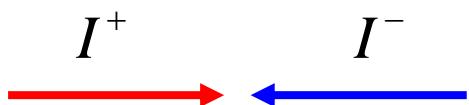
$$\Delta E = \Delta E_{FB} - q\psi_S$$

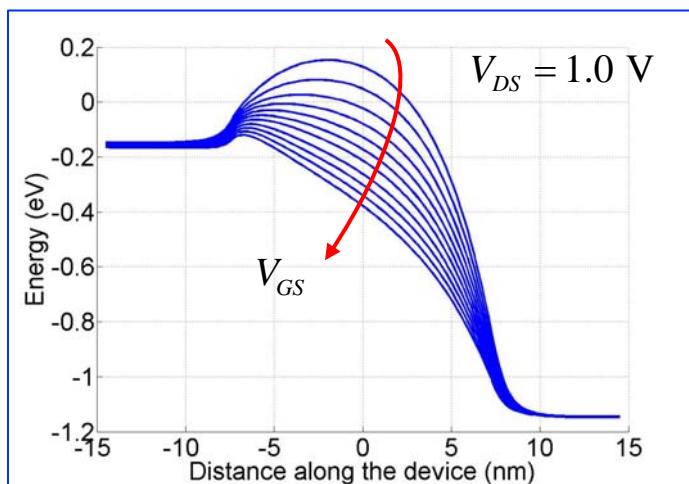
$$I_D \sim e^{q\psi_S/k_B T}$$

$$\psi_S = V_{GS}/m$$

$$I_D \sim e^{qV_{GS}/mk_B T}$$

# IV characteristic for high $V_{DS}$ (above threshold)

$$I^+ \quad \quad I^-$$




$$I_D \propto I^+$$

E.O. Johnson, *RCA Review*, 1971

$$I_D \approx I^+ \sim e^{-\Delta E/k_B T}$$

$$\Delta E = \Delta E_{FB} - q\psi_S$$

$$I_D \sim e^{q\psi_S/k_B T}$$

$$|Q_I| \sim e^{q\psi_S/k_B T}$$

$$|Q_I| = C_{ox} (V_{GS} - V_T)$$

$$\psi_S \sim \ln(V_{GS} - V_T)$$

$$I_D \sim (V_{GS} - V_T)$$

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# drift-diffusion transport

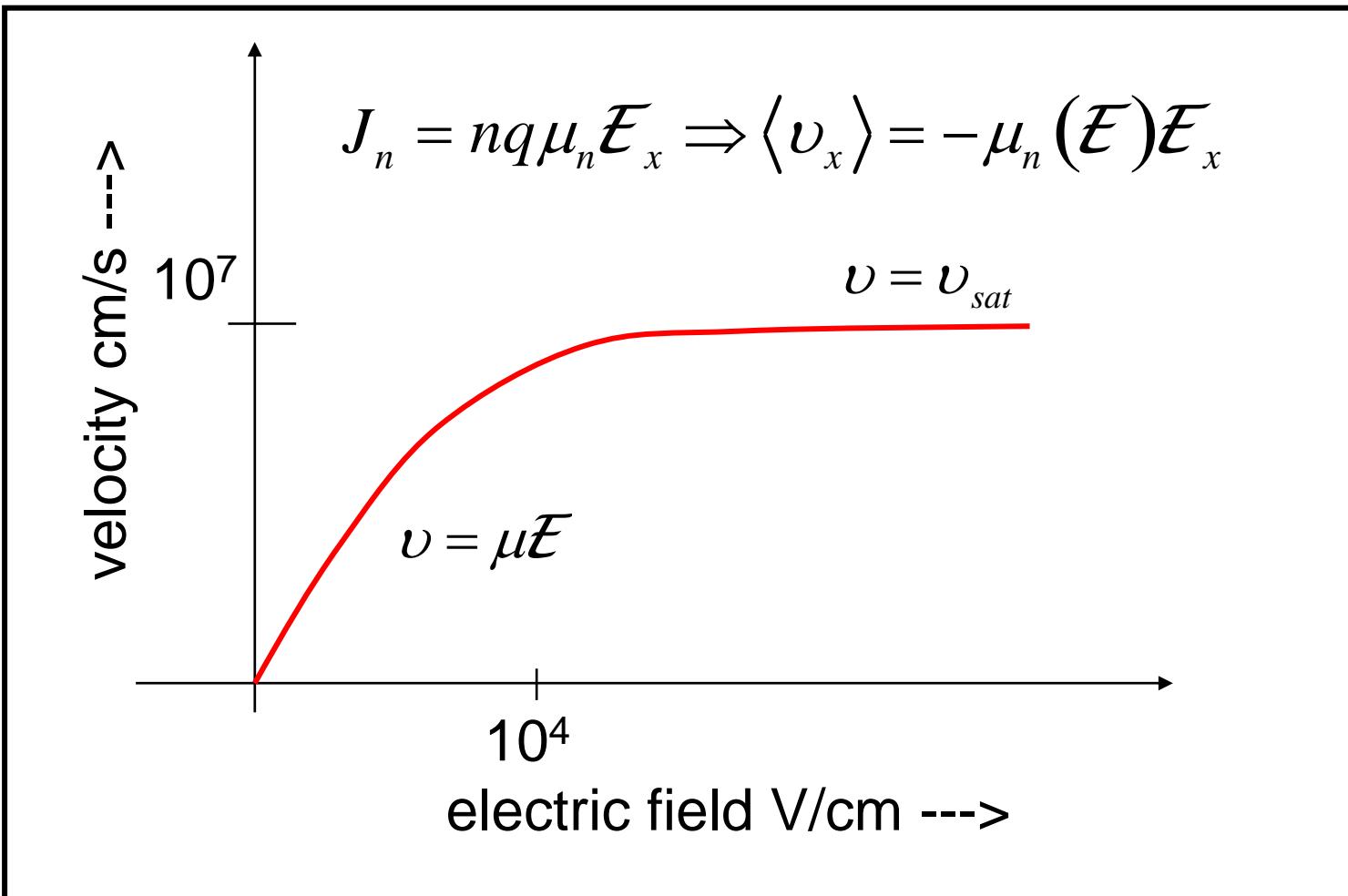
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$$J_n = nq\mu_n \mathcal{E}_x + qD_n \frac{dn}{dx}$$

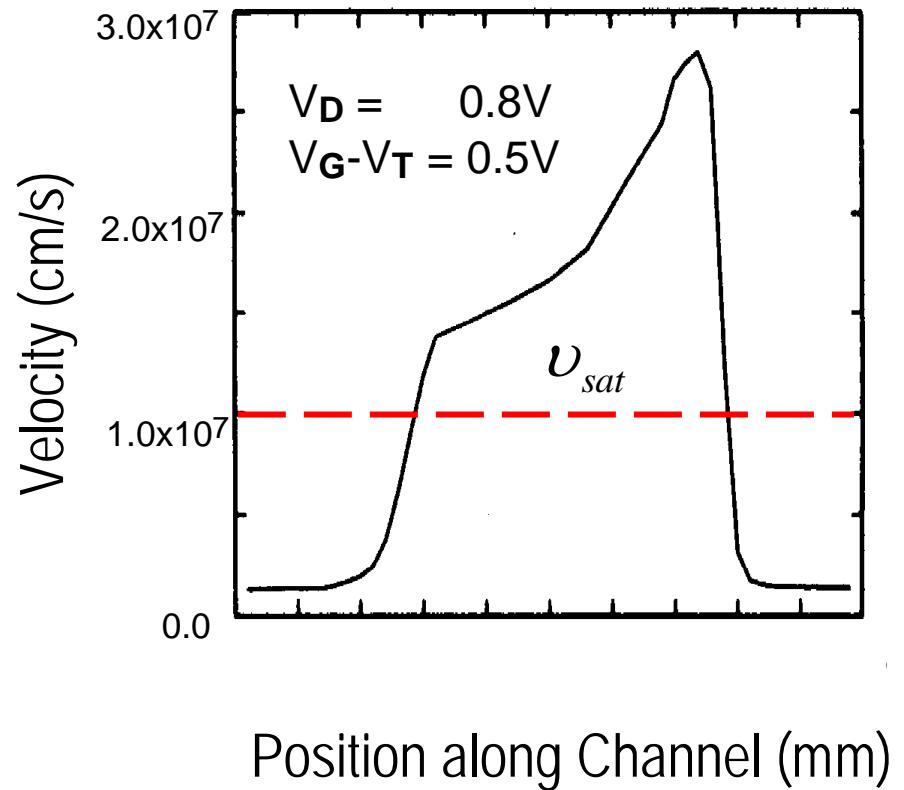
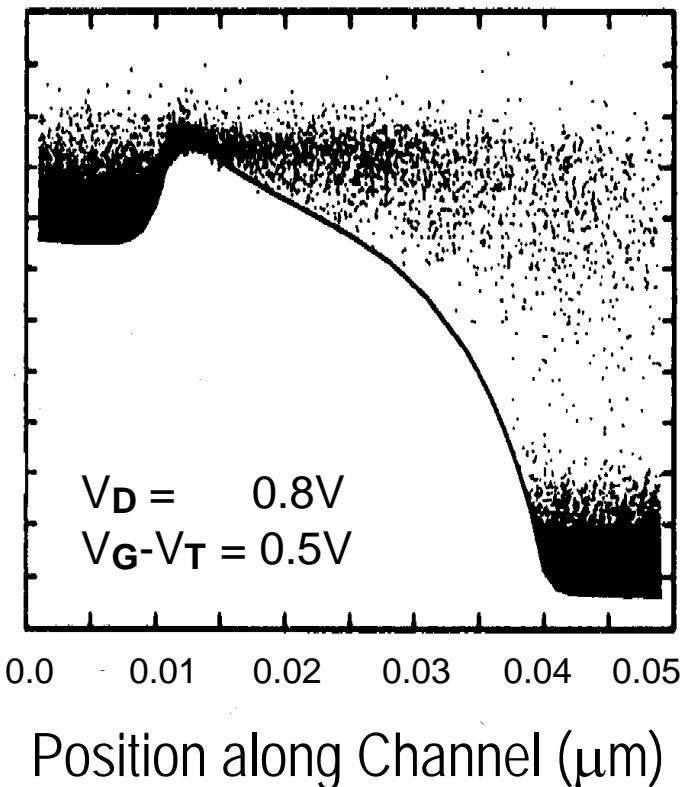
above threshold, drift  
dominates

below threshold,  
diffusion dominates

# velocity saturation



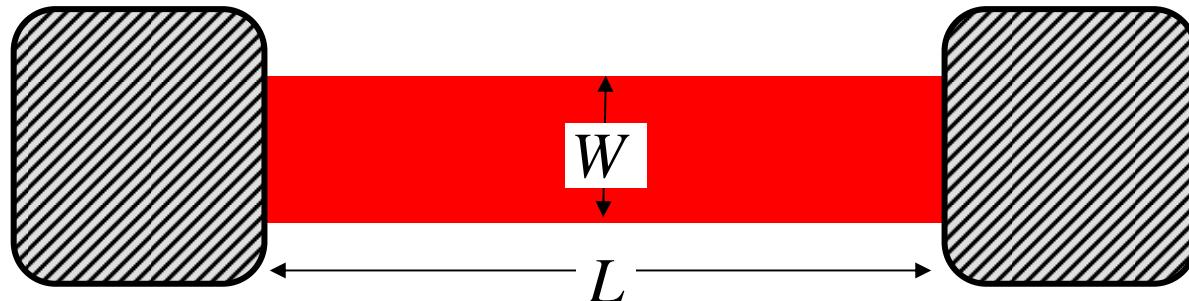
# velocity overshoot in sub-micron MOSFETs



Frank, Laux, and Fischetti, IEDM Tech. Dig., p. 553, 1992

# diffusive vs. ballistic transport

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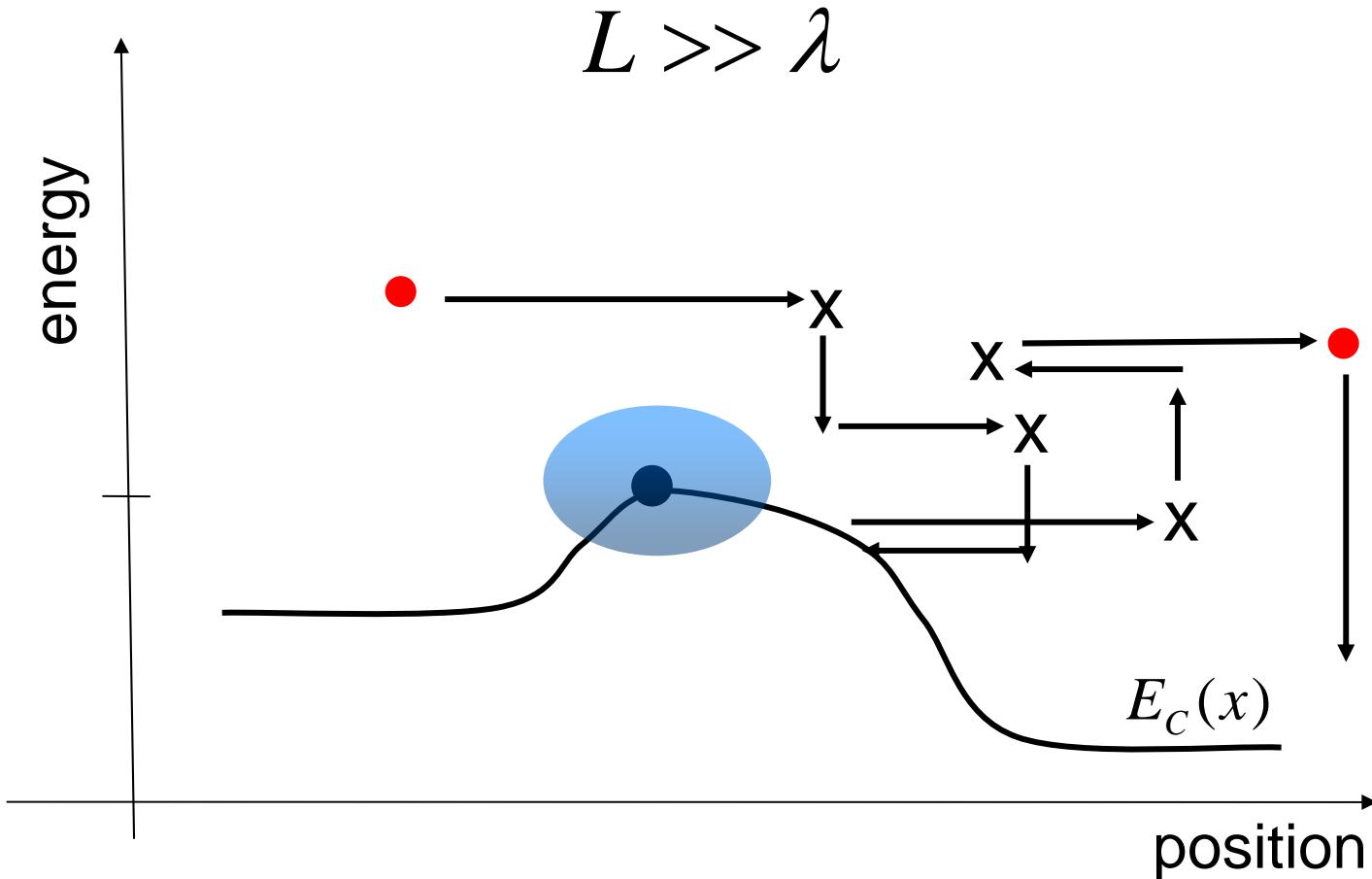
1) diffusive:

$$R = \rho_s (L/W) \quad \rho_s = 1/n_S q \mu_n \quad \langle v_x \rangle = -\mu_n \mathcal{E}_x = \mu_n (V/L)$$

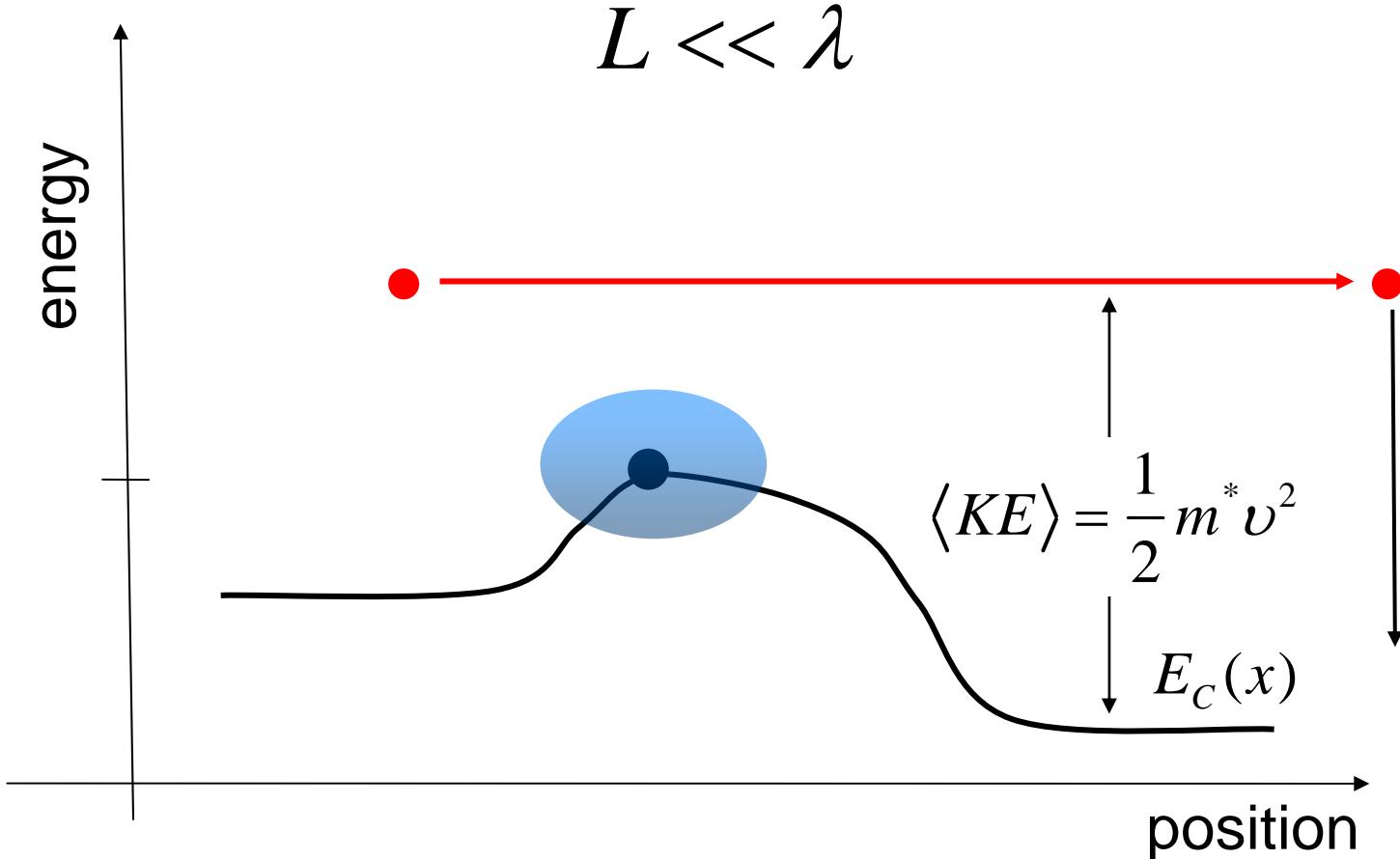
2) ballistic:

$$R = (M 2q^2/h)^{-1} \quad (\text{"quantum contact resistance"} \ T=0 \text{ K})$$

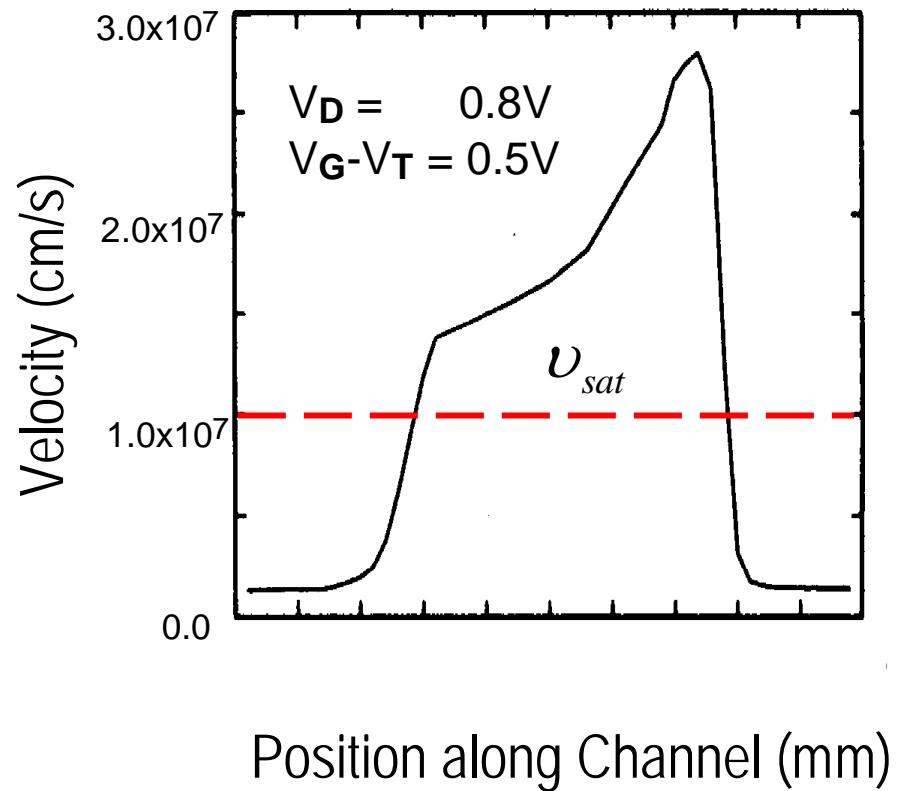
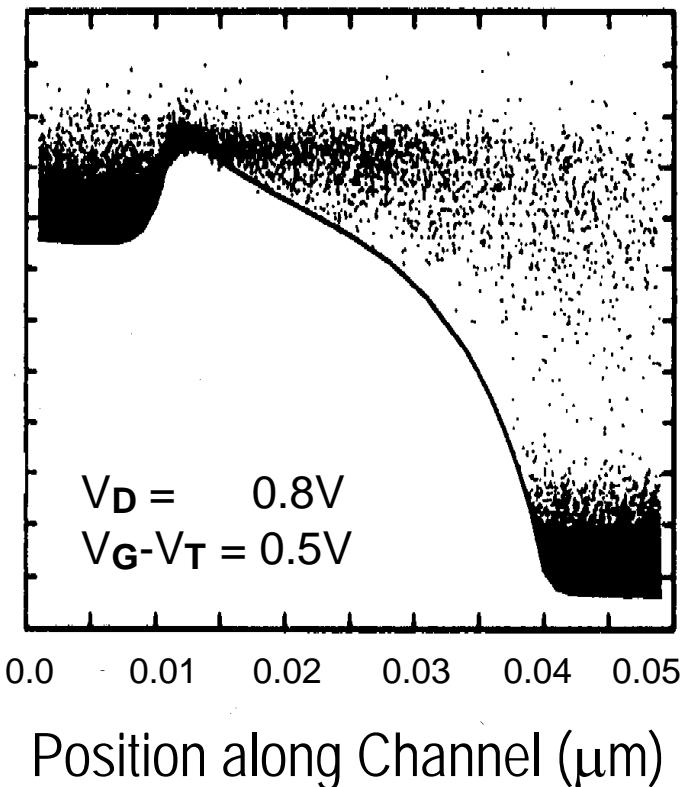
# diffusive transport in a MOSFET



# ballistic transport in a MOSFET



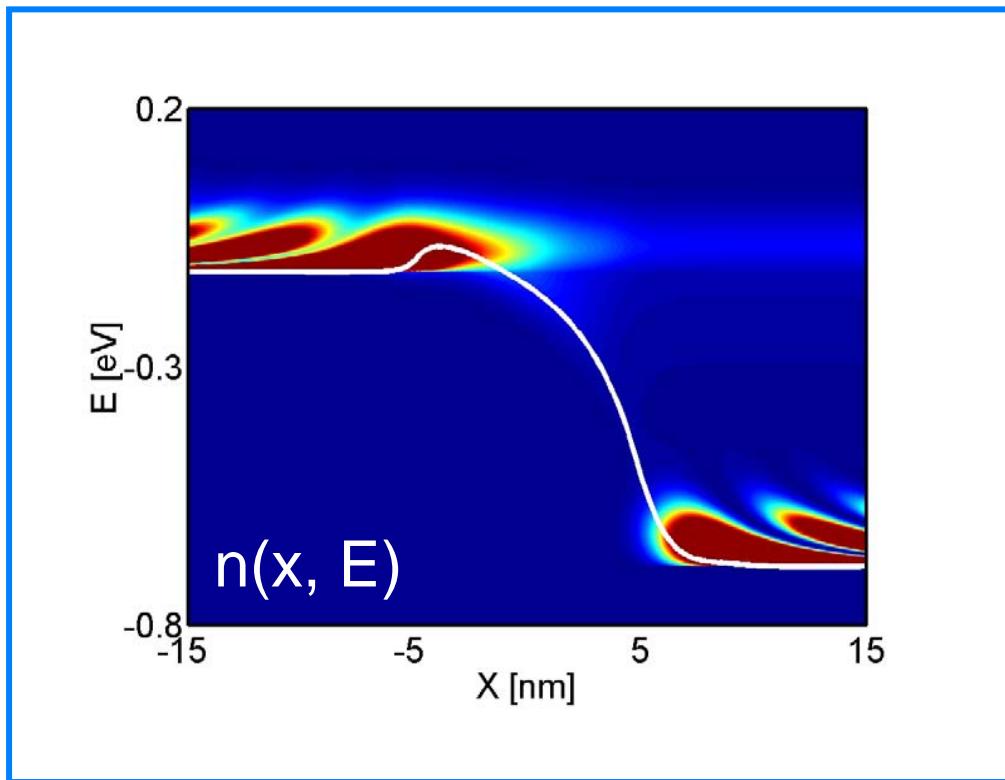
# velocity overshoot in sub-micron MOSFETs



Frank, Laux, and Fischetti, IEDM Tech. Dig., p. 553, 1992

# quantum transport in a nano MOSFET

$L = 10 \text{ nm}$



nanoMOS ([www.nanoHUB.org](http://www.nanoHUB.org))

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- 6) Summary

# summary

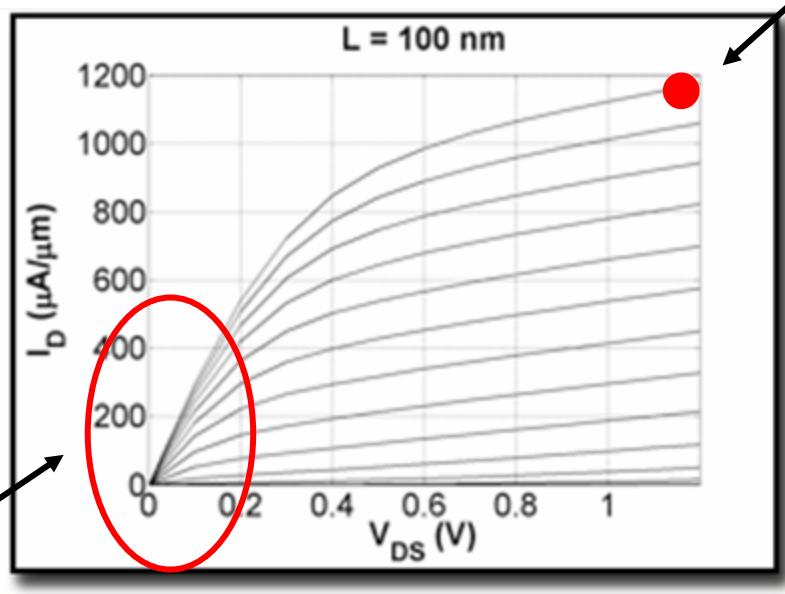
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- 1) Traditional MOSFET theory is based on drift-diffusion and MOS electrostatics.
- 2) MOSFETs are ‘barrier controlled devices.’
- 3) A few key device metrics characterize performance.
- 4) Modern MOSFETs operate between the diffusive and ballistic limits.

# summary

**'Barrier controlled transport' is responsible for the shape of the MOSFET IV characteristic.**

$$I_D = W C_{ox} \nu_{sat} (V_{GS} - V_T)$$



(Courtesy, Shuji Ikeda, ATDF, Dec. 2007)

$$I_D = \frac{W}{L} \mu_{eff} C_{ox} (V_{GS} - V_T) V_{DS}$$

**The specific transport model determines the magnitude of the current.**

# references

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A good reference for this lecture is:

*Fundamentals of Modern VLSI Devices*, by Taur and Ning,  
Cambridge Univ. Press, 1998.

You may also wish to consult the online lectures:

*Nanoscale Transistors*, by Mark Lundstrom,  
[https://www.nanohub.org/courses/nanoscale\\_transistors](https://www.nanohub.org/courses/nanoscale_transistors)

These references discuss the physics of DIBL,  
subthreshold swing, etc.